











LMX2594

SNAS696 - MARCH 2017

# LMX2594 15 GHz Wideband PLLatinum™ RF Synthesizer With Phase Synchronization and JESD204B Support

#### **Features**

- 10-MHz to 15-GHz Output Frequency
- -110 dBc/Hz Phase Noise at 100 kHz Offset With 15 GHz Carrier
- 45-fs rms Jitter at 7.5 GHz (100 Hz to 100 MHz)
- Programmable Output Power Up to 7 dBm at 15 GHz
- PLL Key Specifications
  - Figure of Merit: -236 dBc/Hz
  - Normalized 1/f Noise: -129 dBc/Hz
  - High Phase Detector Frequency
    - 400-MHz Integer Mode
    - 300-MHz Fractional Mode
  - 32-bit Fractional-N Divider
- Remove Integer Boundary Spurs With Programmable Input Multiplier
- Synchronize Output Phase Across Multiple **Devices**
- Support for SYSREF With 9-ps Resolution Programmable Delay
- Frequency Ramp and Chirp Generation Ability for **FMCW Applications**
- < 20-µs VCO Calibration Speed
- 3.3-V Single Power Supply Operation

# **Applications**

- 5G and mm-wave Wireless Infrastructure
- Test and Measurement Equipment
- Radar
- MIMO
- Phased Array Antennas and Beam Forming
- High Speed Data Converter Clocking (Supports JESD204B)

# 3 Description

The LMX2594 is a high-performance, wideband PLL with integrated VCOs that can generate any frequency from 10 MHz to 15 GHz without using an internal doubler, thus eliminating the need for subharmonic filters. The high performance PLL with figure of merit of -236 dBc/Hz and high phase detector frequency can attain very low in-band noise and integrated jitter. The high speed N-divider has no pre-divider, thus significantly reducing the amplitude and number of spurs. There is also a programmable input multiplier to mitigate integer boundary spurs.

The LMX2594 allows users to synchronize the output of multiple devices and also enables applications that need deterministic delay between input and output. A frequency ramp generator can synthesize up to 2 segments of ramp in an automatic ramp generation option or a manual option for maximum flexibility. The fast calibration algorithm allows changing frequencies faster than 20 µs. The LMX2594 adds support for generating or repeating SYSREF (compliant to JESD204B standard) making it an ideal low-noise clock source for high-speed data converters. Fine delay adjustment (9 ps resolution) is provided in this configuration to account for delay differences of board traces.

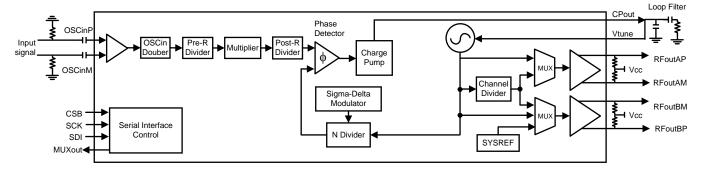
The output drivers within LMX2594 delivers output power as high as 7 dBm at 15 GHz carrier frequency. The device runs from a single 3.3 V supply and has integrated LDOs that eliminate the need for on-board low noise LDOs.

## Device Information<sup>(1)</sup>

| PART NUMBER | PACKAGE   | BODY SIZE (NOM)   |  |
|-------------|-----------|-------------------|--|
| LMX2594     | VQFN (40) | 6.00 mm × 6.00 mm |  |

(1) For all available packages, see the orderable addendum at the end of the data sheet.

### Simplified Schematic





# **Table of Contents**

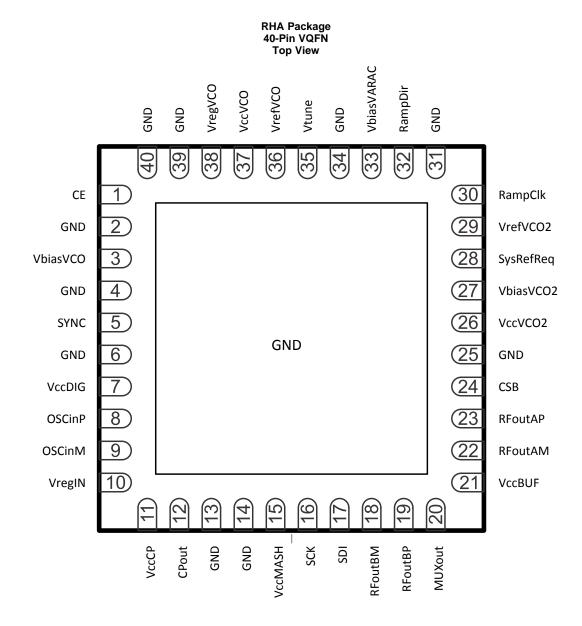
| 1 | Features 1                           | 7.5 Programming 4                                      | 11 |
|---|--------------------------------------|--|----|
| 2 | Applications 1                       | 7.6 Register Maps and Descriptions 4                   | 1  |
| 3 | Description 1                        | 8 Application and Implementation 5                     | 8  |
| 4 | Revision History2                    | 8.1 Application Information 5                          | 8  |
| 5 | Pin Configuration and Functions      | 8.2 Typical Application 6                              | 0  |
| 6 | Specifications5                      | 9 Power Supply Recommendations 6                       | 3  |
| • | 6.1 Absolute Maximum Ratings 5       | 10 Layout 6  | 4  |
|   | 6.2 ESD Ratings                      | 10.1 Layout Guidelines 6                               | 54 |
|   | 6.3 Recommended Operating Conditions | 10.2 Layout Example 6                                  | 55 |
|   | 6.4 Thermal Information              | 11 Device and Documentation Support 6                  | 6  |
|   | 6.5 Electrical Characteristics       | 11.1 Device Support6                                   | 6  |
|   | 6.6 Timing Requirements 8            | 11.2 Documentation Support 6                           | 6  |
|   | 6.7 Typical Characteristics          | 11.3 Receiving Notification of Documentation Updates 6 | 6  |
| 7 | Detailed Description21               | 11.4 Community Resources 6                             | 6  |
| - | 7.1 Overview                         | 11.5 Trademarks 6                                      | 6  |
|   | 7.2 Functional Block Diagram         | 11.6 Electrostatic Discharge Caution 6                 | 6  |
|   | 7.3 Feature Description              | 11.7 Glossary 6  | 6  |
|   | 7.4 Device Functional Modes          | 12 Mechanical, Packaging, and Orderable Information 6  | ;7 |

# 4 Revision History

| DATE       | REVISION | NOTES           |
|------------|----------|-----------------|
| March 2017 | *        | Initial release |



# 5 Pin Configuration and Functions





# **Pin Functions**

|                             | PIN        |        | Pin Functions  |
|-----------------------------|------------|--------|--|
| NO.                         | NAME       | I/O    | DESCRIPTION  |
| 1                           | CE         | Input  | Chip enable input. Active HIGH powers on the device.   |
| 2, 4, 25, 31,<br>34, 39, 40 | GND        | Ground | VCO ground   |
| 3                           | VbiasVCO   | Bypass | VCO bias. Requires connecting 10 μF capacitor to VCO ground. Place close to pin.   |
| 5                           | SYNC       | Input  | Phase synchronization pin. Has programmable threshold.   |
| 6, 14                       | GND        | Ground | Digital ground   |
| 7                           | VccDIG     | Supply | Digital supply. TI recommends bypassing with a 0.1 µF capacitor to digital ground.   |
| 8                           | OSCinP     | Input  | Reference input clock (+). High-impedance self-biasing pin. Requires AC coupling capacitor. (0.1 µF recommended)   |
| 9                           | OSCinM     | Input  | Reference input clock (–). High impedance self-biasing pin. Requires AC coupling capacitor. (0.1 µF recommended)   |
| 10                          | VregIN     | Bypass | Input reference path regulator output. Requires connecting 1 $\mu\text{F}$ capacitor to ground. Place close to pin.  |
| 11                          | VccCP      | Supply | Charge pump supply.TI recommends bypassing with a 0.1 µF capacitor to charge pump ground.  |
| 12                          | CPout      | Output | Charge pump output. TI recommends connecting C1 of loop filter close to pin.   |
| 13                          | GND        | Ground | Charge pump ground   |
| 15                          | VccMASH    | Supply | Digital supply. TI recommends bypassing with a 0.1 µF and 10 µF capacitor to digital ground.   |
| 16                          | SCK        | Input  | SPI clock. High impedance CMOS input. 1.8 to 3.3 V logic.  |
| 17                          | SDI        | Input  | SPI data. High impedance CMOS input. 1.8 to 3.3 V logic.   |
| 18                          | RFoutBM    | Output | Differential output B (–). Requires pullup (typically 50- $\Omega$ resistor) to V <sub>CC</sub> as close as possible to pin. Can be used as an output signal or SYSREF output. |
| 19                          | RFoutBP    | Output | Differential output B (+). Requires pullup (typically $50-\Omega$ resistor) to $V_{CC}$ as close as possible to pin. Can be used as an output signal or SYSREF output.         |
| 20                          | MUXout     | Output | Multiplexed output pin — lock detect, readback, diagnostics, ramp status   |
| 21                          | VccBUF     | Supply | Output buffer supply. TI recommends bypassing with a 0.1 µF capacitor to RFout ground.   |
| 22                          | RFoutAM    | Output | Differential output A (–). Requires connecting 50- $\Omega$ resistor pullup to Vcc as close as possible to pin.  |
| 23                          | RFoutAP    | Output | Differential output A (+). Requires connecting 50- $\Omega$ resistor pullup to Vcc as close as possible to pin.  |
| 24                          | CSB        | Input  | SPI latch. Chip Select Bar . High-impedance CMOS input. 1.8 to 3.3 V logic.  |
| 26                          | VccVCO2    | Supply | VCO supply. TI recommends bypassing with a 0.1 µF and 10 µF capacitor to VCO ground.   |
| 27                          | VbiasVCO2  | Bypass | VCO bias. Requires connecting 1 μF capacitor to VCO ground.  |
| 28                          | SysRefReq  | Input  | SYSREF request input for JESD204B support  |
| 29                          | VrefVCO2   | Bypass | VCO supply reference. Requires connecting 10 µF capacitor to VCO ground.   |
| 30                          | RampClk    | Input  | Input pin for ramping mode that can be used to clock the ramp in manual ramping mode or as a trigger input.  |
| 32                          | RampDir    | Input  | Input pin for ramping mode that can be used to change ramp direction in manual ramping mode or as a trigger input.   |
| 33                          | VbiasVARAC | Bypass | VCO Varactor bias. Requires connecting 10 µF capacitor to VCO ground.  |
| 35                          | Vtune      | Input  | VCO tuning voltage input.  |
| 36                          | VrefVCO    | Bypass | VCO supply reference. Requires connecting 10 μF capacitor to ground.   |
| 37                          | VccVCO     | Supply | VCO supply. Recommend bypassing with 0.1 μF and 10 μF capacitor to ground.   |
| 38                          | VregVCO    | Bypass | VCO regulator node. Requires connecting 1 µF capacitor to ground.  |
| DAP                         | GND        | Ground | RFout ground   |

# 6 Specifications

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#### 6.1 Absolute Maximum Ratings

over operating free-air temperature range (unless otherwise noted)(1)

|                  |                      | MIN  | MAX | UNIT |
|------------------|----------------------|------|-----|------|
| $V_{CC}$         | Power supply voltage | -0.3 | 3.6 | V    |
| $T_{J}$          | Junction temperature | -40  | 150 | °C   |
| T <sub>sta</sub> | Storage temperature  | -65  | 150 | °C   |

<sup>(1)</sup> Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. These are stress ratings only, which do not imply functional operation of the device at these or any other conditions beyond those indicated under Recommended Operating Conditions. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

# 6.2 ESD Ratings

|                    |                         |   | VALUE | UNIT |
|--------------------|-------------------------|---|-------|------|
|                    |                         | Human-body model (HBM), per ANSI/ESDA/JEDEC JS-001 (1)              | ±2000 |      |
| V <sub>(ESD)</sub> | Electrostatic discharge | Charged-device model (CDM), per JEDEC specification JESD22-C101 (2) | ±750  | V    |

<sup>(1)</sup> JEDEC document JEP155 states that 500 V HBM allows safe manufacturing with a standard ESD control process. Manufacturing with less than 500 V HBM is possible with the necessary precautions. Pins listed as ±XXX V may actually have higher performance.

# 6.3 Recommended Operating Conditions

over operating free-air temperature range (unless otherwise noted)

|                | • |      |     |      |      |
|----------------|---|------|-----|------|------|
|                |   | MIN  | NOM | MAX  | UNIT |
| $V_{CC}$       | Power supply voltage                    | 3.15 | 3.3 | 3.45 | V    |
| T <sub>A</sub> | Ambient temperature                     | -40  | 25  | 85   | °C   |
| $T_{J}$        | Junction Temperature                    |      |     | 125  | °C   |

### 6.4 Thermal Information

|                      | THERMAL METRIC <sup>(1)</sup>                 | RHA (VQFN) | UNIT |
|----------------------|---|------------|------|
|                      |   | 40 PINS    |      |
| $R_{\theta JA}$      | Junction-to-ambient thermal resistance        | 30.5       | °C/W |
| $R_{\theta JC(top)}$ | Junction-to-case (top) thermal resistance (2) | 15.3       | °C/W |
| $R_{\theta JB}$      | Junction-to-board thermal resistance          | 5.4        | °C/W |
| ΨЈΤ                  | Junction-to-top characterization parameter    | 0.2        | °C/W |
| ΨЈВ                  | Junction-to-board characterization parameter  | 5.3        | °C/W |
| $R_{\theta JC(bot)}$ | Junction-to-case (bottom) thermal resistance  | 0.9        | °C/W |

For more information about traditional and new thermal metrics, see the Semiconductor and IC Package Thermal Metrics application report.

(2) DAP

<sup>(2)</sup> JEDEC document JEP157 states that 250 V CDM allows safe manufacturing with a standard ESD control process. Manufacturing with less than 250 V CDM is possible with the necessary precautions. Pins listed as ±YYY V may actually have higher performance.

# **STRUMENTS**

#### 6.5 Electrical Characteristics

 $3.15 \text{ V} \le \text{V}_{CC} \le 3.45 \text{ V}, -40 ^{\circ}\text{C} \le \text{T}_{A} \le +85 ^{\circ}\text{C}$ . Typical values are at  $\text{V}_{CC} = 3.3 \text{ V}, 25 ^{\circ}\text{C}$  (unless otherwise noted)

|                        | PARAMETER   | TEST CO                                    | NDITIONS                  | MIN   | TYP  | MAX  | UNIT   |
|------------------------|---|--|---------------------------|-------|------|------|--------|
| POWER                  | SUPPLY  |  | •                         |       |      | ·    |        |
| V <sub>CC</sub>        | Supply voltage  |  |                           | 3.15  | 3.3  | 3.45 | V      |
| I <sub>CC</sub>        |   |  | JX = 1                    |       | 340  |      | mA     |
|                        | Power on reset current                                  | RESET=1                                    |                           |       | 170  |      |        |
|                        | Power down current                                      | POWERDOWN=1                                |                           |       | 5    |      |        |
| OUTPUT                 | CHARACTERISTICS   |  |                           |       |      | ,    |        |
|                        |   | 50-Ω resistor pullup                       | f <sub>OUT</sub> = 8 GHz  |       | 5    |      |        |
| _                      | 0'(1)   | OUTx_PWR = 50                              | f <sub>OUT</sub> = 15 GHz |       | 2    |      | JD     |
| Роит                   | Single-ended output power <sup>(1)</sup>                | 1-nH inductor pullup                       | f <sub>OUT</sub> = 8 GHz  |       | 10   |      | dBm    |
|                        |   | OUTx_PWR = 50                              | f <sub>OUT</sub> = 15 GHz |       | 7    |      |        |
| Xtalk                  | Isolation between outputs A and B. Measured on output A | OUTA_MUX = VCO OUTB_MUX = channel divider  |                           |       | -50  |      | dBc    |
| H2                     | Second Harmonic <sup>(1)</sup>                          | OUTA_MUX = VCO<br>f <sub>VCO</sub> = 8 GHz |                           |       | -20  |      | dBc    |
| НЗ                     | Third Harmonic <sup>(1)</sup>                           | OUTA_MUX = VCO<br>f <sub>VCO</sub> = 8 GHz |                           |       | -50  |      | dBc    |
| INPUT SI               | GNAL PATH   |  |                           |       |      | ,    |        |
|                        | Defense a input for success.                            | OSC_2X = 0                                 |                           | 5     |      | 1400 | MHz    |
| f <sub>OSCin</sub>     | Reference input frequency                               | OSC_2X = 1                                 |                           | 5     |      | 200  |        |
| V <sub>OSCin</sub>     | Reference input voltage                                 | AC-coupled required (2)                    |                           | 0.2   |      | 2    | Vpp    |
|                        | Multiplier frequency (only                              | Input range                                |                           | 30    |      | 70   |        |
| f <sub>MULT</sub>      | applies when multiplier is enabled)                     | Output range                               |                           | 180   |      | 250  | MHz    |
| PHASE D                | DETECTOR AND CHARGE PUMP                                |  |                           |       |      |      |        |
|                        |   | Integer mode                               | FRAC_ORDER = 0            | 0.125 |      | 400  |        |
| $f_{PD}$               | Phase detector frequency (2)                            |  | FRAC_ORDER = 1,2,3        | 5     |      | 300  | MHz    |
| 10                     | , ,   | Fractional mode                            | FRAC_ORDER = 4            | 5     |      | 240  |        |
|                        | Charge-pump leakage current                             | CPG = 0                                    |                           |       | 15   |      | nA     |
|                        |   | CPG = 4                                    |                           |       | 3    |      | -      |
|                        | Effective charge pump current.                          | CPG = 1                                    |                           |       | 6    |      |        |
| I <sub>CPout</sub>     | This is the sum of the up and                           | CPG = 5                                    |                           |       | 9    |      | mA     |
|                        | down currents   | CPG = 3                                    |                           |       | 12   |      |        |
|                        |   | CPG = 7                                    |                           |       | 15   |      |        |
| PN <sub>PLL_1/f</sub>  | Normalized PLL 1/f noise                                | f _ 100 MU = f 40                          | CH <sub>7</sub> (3)       |       | -129 |      | dBc/Hz |
| PN <sub>PLL_flat</sub> |   | $f_{PD} = 100 \text{ MHz}, f_{VCO} = 12$   | GUIZ (**)                 |       | -236 |      | dBc/Hz |

Output power, spurs, and harmonics can vary based on board layout and components.

For lower VCO frequencies, the N divider minimum value can limit the phase-detector frequency.

The PLL noise contribution is measured using a clean reference and a wide loop bandwidth and is composed into flicker and flat components. PLL\_flat = PLL\_FOM + 20 × log(Fvco/Fpd) + 10 × log(Fyco / 1Hz). PLL\_flicker (offset) = PLL\_flicker\_Norm + 20\*log(Fvco / 1GHz) – 10\*log(offset / 10kHz). Once these two components are found, the total PLL noise can be calculated as PLL\_Noise = 10 × log(10 PLL\_Flat / 10 + 10 PLL\_flicker / 10)



# **Electrical Characteristics (continued)**

 $3.15~V \le V_{CC} \le 3.45~V, -40^{\circ}C \le T_{A} \le +85^{\circ}C.$  Typical values are at  $V_{CC} = 3.3~V, 25^{\circ}C$  (unless otherwise noted).

|   | PARAMETER   | TEST                                | CONDITIONS | MIN TYP MAX  | UNIT  |
|---|---|-------------------------------------|------------|--------------|-------|
| VCO CHA   | ARACTERISTICS   |                                     |            | ·            |       |
|   |   |                                     | 10 kHz     | - 80         |       |
|   |   |                                     | 100 kHz    | - 107        |       |
|   |   | VCO1<br>f <sub>VCO</sub> = 8.0 GHz  | 1 MHz      | - 128        |       |
|   |   | 1000 = 0.0 0112                     | 10 MHz     | - 148        |       |
|   | VCO phase noise   |                                     | 90 MHz     | <b>– 157</b> |       |
|   |   |                                     | 10 kHz     | <b>– 79</b>  | 1     |
|   |   |                                     | 100 kHz    | <b>– 105</b> |       |
|   |   | VCO2<br>f <sub>VCO</sub> = 9.2 GHz  | 1 MHz      | - 127        |       |
|   |   | 1000 = 9.2 0112                     | 10 MHz     | - 147        |       |
|   |   |                                     | 90 MHz     | <b>– 157</b> |       |
|   |   |                                     | 10 kHz     | - 77         |       |
|   |   |                                     | 100 kHz    | - 104        |       |
|   |   | VCO3<br>f <sub>VCO</sub> = 10.3 GHz | 1 MHz      | - 126        |       |
|   |   | 10.3 6112                           | 10 MHz     | - 147        |       |
|   |   |                                     | 90 MHz     | <b>– 157</b> | dBc/H |
|   |   | VCO4<br>f <sub>VCO</sub> = 11.3 GHz | 10 kHz     | - 76         |       |
|   |   |                                     | 100 kHz    | - 103        |       |
| N <sub>VCO</sub>  | VCO phase noise   |                                     | 1 MHz      | <b>– 125</b> |       |
|   |   |                                     | 10 MHz     | <b>– 145</b> |       |
|   |   |                                     | 90 MHz     | - 158        |       |
|   |   |                                     | 10 kHz     | - 74         |       |
|   |   |                                     | 100 kHz    | - 100        | 1     |
|   | VCO Calibration Speed, Switch Across the entire frequency Band, f <sub>OSC</sub> = 200 MHz, f <sub>PD</sub> = 100 MHz | VCO5                                | 1 MHz      | - 123        |       |
| VCO Calibration Speed, Switc  | f <sub>VCO</sub> = 12.5 GHz   | 10 MHz                              | - 144      |              |       |
|   |   | 90 MHz                              | - 157      |              |       |
|   |   |                                     | 10 kHz     | - 73         |       |
|   |   |                                     | 100 kHz    | - 100        |       |
|   |   | VCO6                                | 1 MHz      | - 122        |       |
|   |   | $f_{VCO} = 13.3 \text{ GHz}$        | 10 MHz     | - 143        |       |
|   |   |                                     | 90 MHz     | - 155        |       |
|   |   |                                     | 10 kHz     | - 73         |       |
|   |   |                                     | 100 kHz    | -99          | 1     |
|   |   | VCO7                                | 1 MHz      | - 121        | 1     |
|   |   | $f_{VCO} = 14.5 \text{ GHz}$        | 10 MHz     | - 143        | 1     |
|   |   |                                     | 90 MHz     | - 152        | 1     |
|   | VCO Calibration Speed. Switch   | No assist                           |            | 50           |       |
|   | Across the entire frequency   | Partial assist                      |            | 35           | 1     |
| Across the entire frequence Band, f <sub>OSC</sub> = 200 MHz, 100 MHz |   | Close frequency                     |            | 20           | μs    |
|   |   | Full assist                         |            | 5            |       |

<sup>(4)</sup> See Application and Implementation for more details on the different VCO calibration modes.

# TEXAS INSTRUMENTS

# **Electrical Characteristics (continued)**

 $3.15 \text{ V} \le \text{V}_{\text{CC}} \le 3.45 \text{ V}$ ,  $-40^{\circ}\text{C} \le \text{T}_{\text{A}} \le +85^{\circ}\text{C}$ . Typical values are at  $\text{V}_{\text{CC}} = 3.3 \text{ V}$ ,  $25^{\circ}\text{C}$  (unless otherwise noted).

|                       | PARAMETER  | TEST COI                               | NDITIONS                                   | MIN          | TYP      | MAX                   | UNIT    |
|-----------------------|--|--|--|--------------|----------|-----------------------|---------|
|                       |  | 8.0 GHz                                |  |              | 73       |                       |         |
|                       |  | 9.2 GHz                                |  |              | 76       |                       |         |
|                       | 8.0 GHz 9.2 GHz 10.3 GHz 11.3 GHz 12.5 GHz 13.3 GHz 14.5 GHz  VCO second harmonic VCO third haromonic VCO = 8 GHz, divider disabled  Category 3 Categories1 and 2  SITAL INTERFACE, Applies to SCLK, SDA, CSB, RampDir, RampCLK, MUXout, SYNC High level input voltage Low level input voltage High level input current Low level input current Low level input voltage High level output voltage High level output voltage Low level input current Low level input current Low level output voltage  High level output voltage Load current = -10 m |  |  | 94           |          |                       |         |
| $K_{VCO}$             | VCO Gain   | 11.3 GHz                               |  |              | 86       |                       | MHz/V   |
|                       |  | 12.5 GHz                               |  |              | 149      |                       |         |
|                       |  | 13.3 GHz                               |  |              | 135      |                       |         |
|                       |  | 14.5 GHz                               |  |              | 154      |                       |         |
| ΔT <sub>CL</sub>      |  | RAMP_EN = 0 or RAMP_MANUAL= 1          |  |              | 125      |                       | °C      |
| H2                    | VCO second harmonic  | f <sub>VCO</sub> = 8 GHz, divider disa | f <sub>VCO</sub> = 8 GHz, divider disabled |              | -20      |                       | -ID -   |
| НЗ                    | VCO third haromonic  | f <sub>VCO</sub> = 8 GHz, divider disa | f <sub>VCO</sub> = 8 GHz, divider disabled |              | -50      |                       | dBc     |
| SYNC PII              | N AND PHASE ALIGNMENT  |  |  |              |          |                       |         |
| f <sub>OSCin</sub> SY |  | Category 3                             |  | 0            |          | 100                   |         |
| NC                    |  | Categories1 and 2                      |  | 0            |          | 1400                  | MHz     |
| DIGITAL               | INTERFACE, Applies to SCLK, \$   | SDA, CSB, RampDir, Ram                 | pCLK, MUXout, SYNC (C                      | MOS Mode), S | ysRefReq | (CMOS                 | S Mode) |
| V <sub>IH</sub>       | High level input voltage   |  |  | 1.4          |          | Vcc                   | V       |
| $V_{IL}$              | Low level input voltage  |  |  | 0            |          | 0.4                   | V       |
| I <sub>IH</sub>       | High level input current   |  |  | -25          |          | 25                    | μΑ      |
| I <sub>IL</sub>       | Low level input current  |  |  | -25          |          | 25                    | μΑ      |
| V <sub>OH</sub>       | High level output voltage  | MUXout pin                             | Load current = -10 mA                      |              |          | V <sub>CC</sub> – 0.4 | V       |
| V <sub>OL</sub>       | High level output current  | ] '                                    | Load current = 10 mA                       | 0.4          |          |                       | V       |

# 6.6 Timing Requirements

 $(3.15 \text{ V} \le \text{V}_{CC} \le 3.45 \text{ V}, -40^{\circ}\text{C} \le \text{T}_{A} \le +85^{\circ}\text{C}, \text{ except as specified. Nominal values are at V}_{CC} = 3.3 \text{ V}, \text{T}_{A} = 25^{\circ}\text{C})$ 

|                        |   |   | MIN | NOM | MAX | UNIT |
|------------------------|---|---|-----|-----|-----|------|
| SYNC, SY               | SRefReq, RampCLK, and RampDIR Pins          |   | •   |     |     |      |
|                        | Setup time for pin relative to OSCin rising | SYNC pin  | 2.5 |     |     |      |
| t <sub>SETUP</sub>     | edge  | SysRefReq pin                                   | 2.5 |     |     | ns   |
|                        | Hold time for SYNC pin relative to OSCin    | SYNC pin  | 2   |     |     |      |
| t <sub>HOLD</sub>      | rising edge                                 | SysRefReq pin                                   | 2   |     |     | ns   |
| DIGITAL I              | NTERFACE WRITE SPECIFICATIONS               |   | •   |     | •   |      |
| f <sub>SPI</sub> Write | SPI write speed                             | t <sub>CWL</sub> + t <sub>CWH</sub> > 13.333 ns |     |     | 75  | MHz  |
| t <sub>ES</sub>        | Clock to enable low time                    |   | 5   |     |     | ns   |
| t <sub>CS</sub>        | Data to clock setup time                    |   | 2   |     |     | ns   |
| t <sub>CH</sub>        | Data to clock hold time                     |   | 2   |     |     | ns   |
| t <sub>CWH</sub>       | Clock pulse width high                      | See Figure 1                                    | 5   |     |     | ns   |
| t <sub>CWL</sub>       | Clock pulse width low                       |   | 5   |     |     | ns   |
| t <sub>CES</sub>       | Enable to clock setup time                  |   | 5   |     |     | ns   |
| t <sub>EWH</sub>       | Enable pulse width high                     |   | 2   |     |     | ns   |



SNAS696 - MARCH 2017

# **Timing Requirements (continued)**

 $(3.15 \text{ V} \le \text{V}_{CC} \le 3.45 \text{ V}, -40^{\circ}\text{C} \le \text{T}_{A} \le +85^{\circ}\text{C}, \text{ except as specified. Nominal values are at V}_{CC} = 3.3 \text{ V}, \text{T}_{A} = 25^{\circ}\text{C})$ 

| (contract of the contract of t |                            |              |     |        |        |  |  |
|--|----------------------------|--------------|-----|--------|--------|--|--|
|  |                            |              | MIN | NOM MA | X UNIT |  |  |
| DIGITAL INTERFACE READBACK SPECIFICATIONS  |                            |              |     |        |        |  |  |
| f <sub>SPI</sub> Readb<br>ack  | SPI readback speed         |              |     | 5      | 0 MHz  |  |  |
| t <sub>ES</sub>  | Clock to enable low time   |              | 10  |        | ns     |  |  |
| t <sub>CS</sub>  | Clock to data wait time    |              |     | 1      | 0 ns   |  |  |
| t <sub>CWH</sub>   | Clock pulse width high     | See Figure 2 | 10  |        | ns     |  |  |
| $t_{CWL}$  | Clock pulse width low      |              | 10  |        | ns     |  |  |
| t <sub>CES</sub>   | Enable to clock setup time |              | 10  |        | ns     |  |  |
| $t_{\text{EWH}}$   | Enable pulse width high    |              | 10  |        | ns     |  |  |

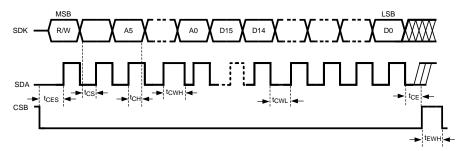


Figure 1. Serial Data Input Timing Diagram

There are several other considerations for writing on the SPI:

- The R/W bit must be set to 0.
- The data on SDA pin is clocked into a shift register on each rising edge on the SCK pin.
- The CSB must be held low for data to be clocked. Device will ignore clock pulses if CSB is held high.
- The CSB transition from high to low must occur when SCK is low.
- When SCK and SDA lines are shared between devices, TI recommends hold the CSB line high on the device that is not to be clocked.

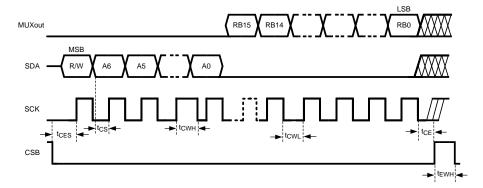


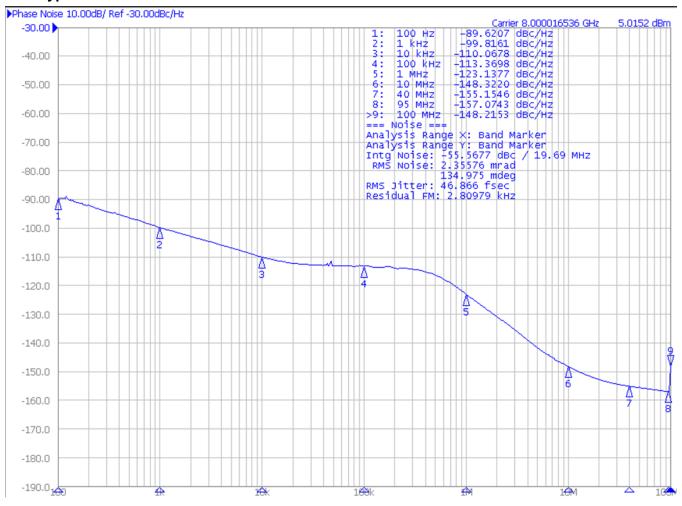
Figure 2. Serial Data Readback Timing Diagram

There are several other considerations for SPI readback:

- The R/W bit must be set to 1.
- The MUXout pin will always be low for the address portion of the transaction.
- The data on SDA is clocked out on the rising edge of SCK.
- The data portion of the transition on the SDA line is always ignored.

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# 6.7 Typical Characteristics



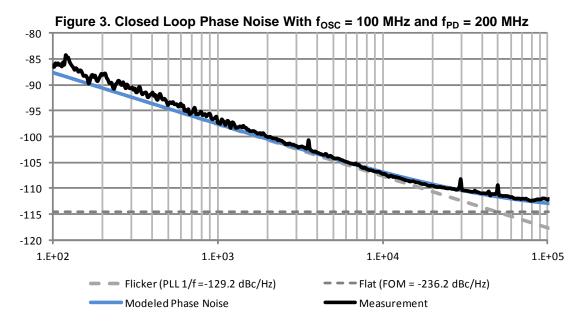
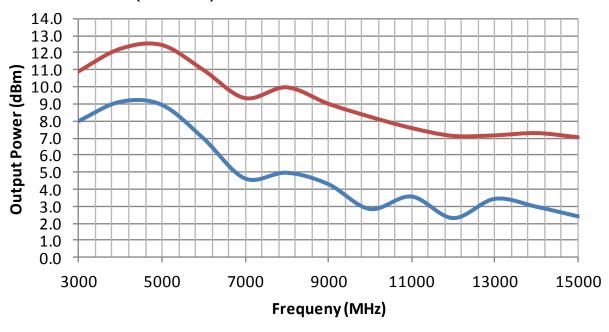


Figure 4. Calculation of PLL Noise Metrics of PLL  $f_{PD}$ =100 MHz,  $f_{VCO}$  = 12 GHz



# **Typical Characteristics (continued)**



Resistor Pull-up (OUTx\_PWR=50) Inductor Pull-Up (OUTx\_PWR=50)

Figure 5. Output Power vs Pullup

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# **Typical Characteristics (continued)**

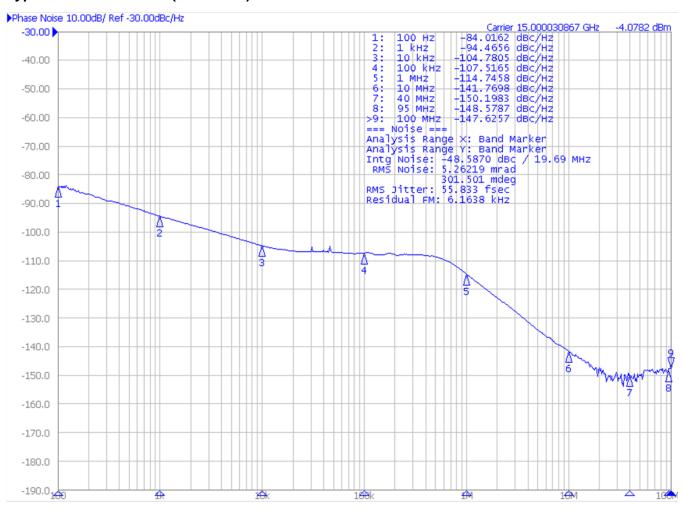


Figure 6. Closed Loop Phase Noise at 15 GHz With  $f_{OSC}$  = 100 MHz and  $f_{PD}$  = 200 MHz



# **Typical Characteristics (continued)**

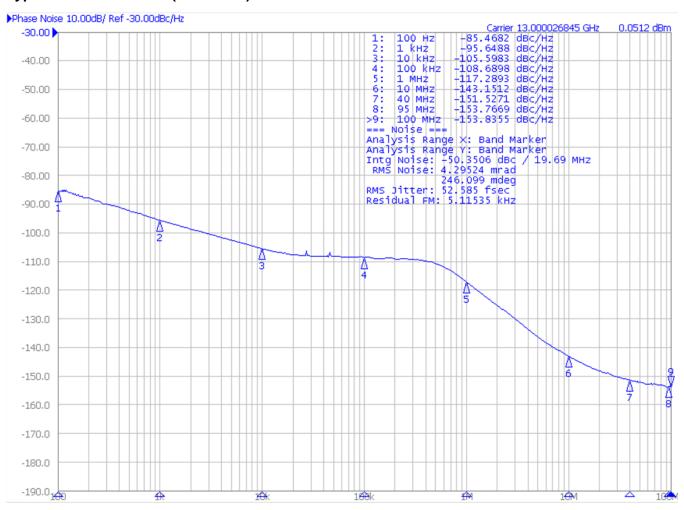


Figure 7. Closed Loop Phase Noise at 13 GHz With  $f_{OSC}$  = 100 MHz and  $f_{PD}$  = 200 MHz

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# **Typical Characteristics (continued)**

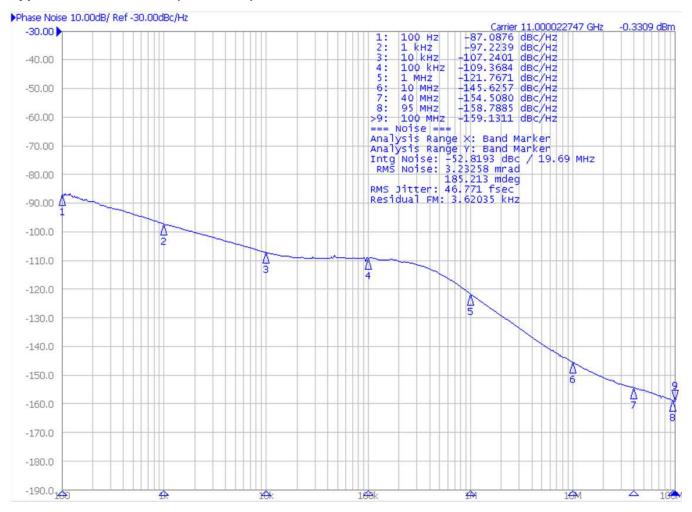


Figure 8. Closed Loop Phase Noise at 11 GHz With  $f_{OSC}$  = 100 MHz and  $f_{PD}$  = 200 MHz



# **Typical Characteristics (continued)**

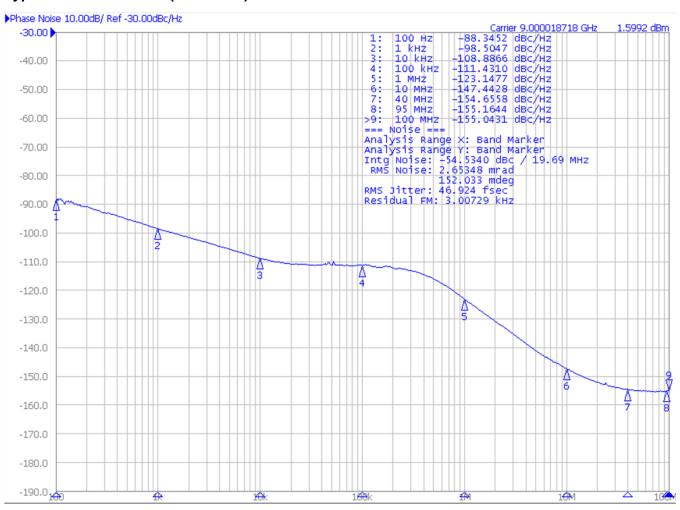


Figure 9. Closed Loop Phase Noise at 9 GHz With  $f_{OSC}$  = 100 MHz and  $f_{PD}$  = 200 MHz

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# **Typical Characteristics (continued)**

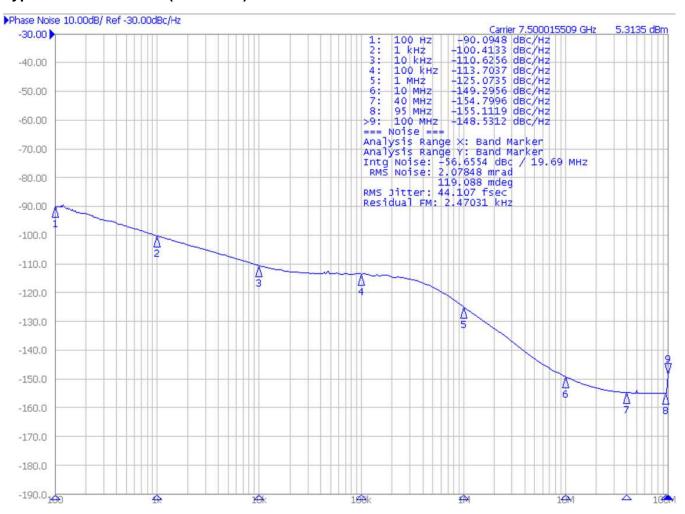


Figure 10. Closed Loop Phase Noise at 7.5 GHz With  $f_{OSC}$  = 100 MHz and  $f_{PD}$  = 200 MHz

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# **Typical Characteristics (continued)**

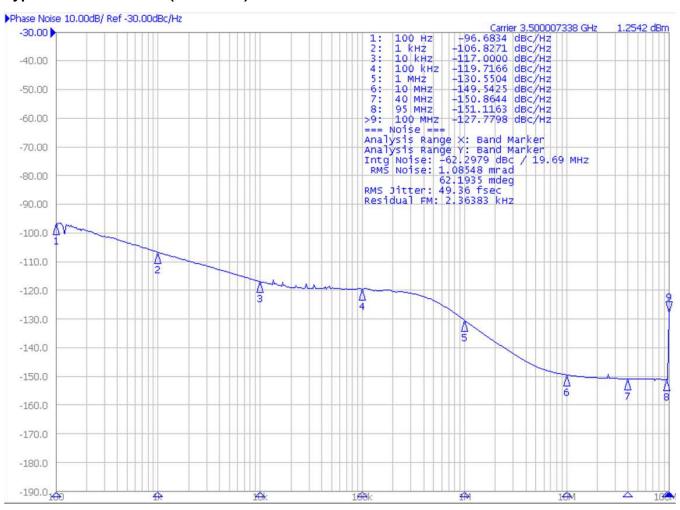


Figure 11. Closed Loop phase noise at 3.5 GHz With  $f_{VCO}$  = 100,  $f_{OSC}$  = 100 MHz, and  $f_{PD}$  = 200 MHz

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# **Typical Characteristics (continued)**

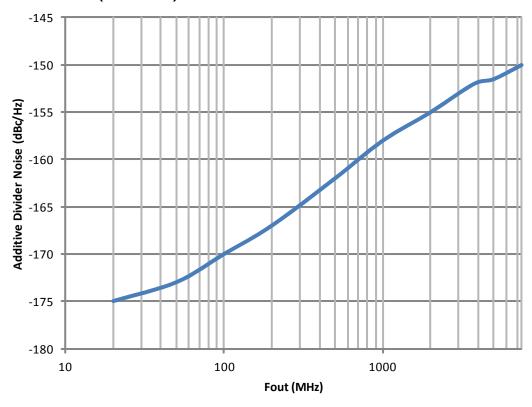
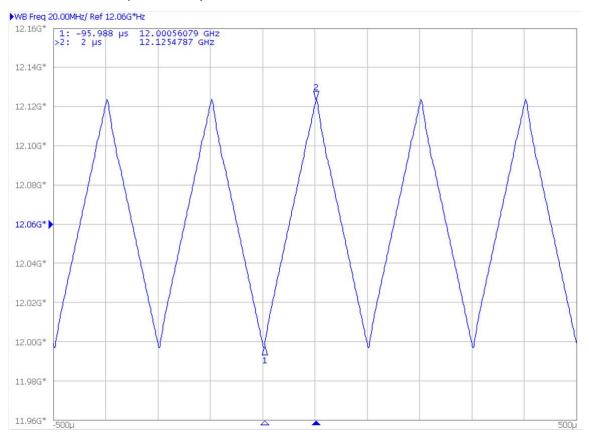


Figure 12. Additive VCO Divider Noise Floor (Adds to the divided far out VCO noise when output divider is used.)



# **Typical Characteristics (continued)**



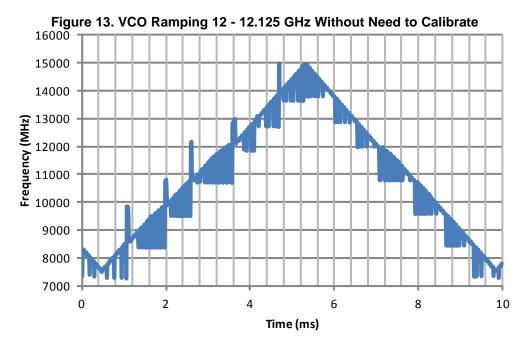


Figure 14. VCO Ramping 7.5 to 15 GHz Triangle Wave with VCO Calibration (The glitches in the plot are due to inability of the measurement equipment to track the VCO while calibrating.)

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# **Typical Characteristics (continued)**

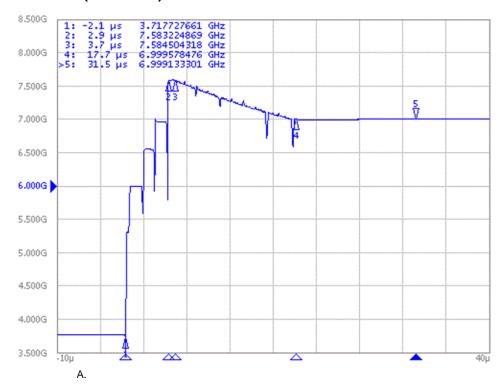


Figure 15. VCO unassisted calibration from 7.5 - 14 GHz in 33.6  $\mu s$  CHDIV=2,  $f_{OSC}{=}200$  MHz,  $f_{PD}{=}100$  MHz

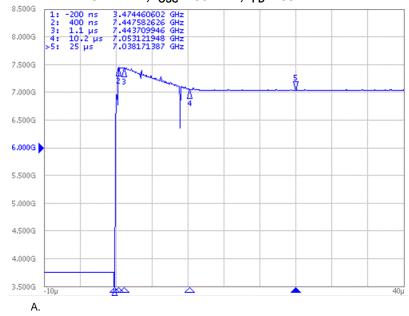


Figure 16. VCO Calibration with partial assist from 7.5 - 14 GHz in 25.2  $\mu$ s CHDIV=2,  $f_{OSC}$  = 200 MHz,  $f_{PD}$  = 100 MHz.

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# 7 Detailed Description

#### 7.1 Overview

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The LMX2594 is a high-performance, wideband frequency synthesizer with integrated VCO and output divider. The VCO operates from 7.5 to 15 GHz and this can be combined with the output divider to produce any frequency in the range of 10 MHz to 15 GHz. Within the input path there are two dividers and a multiplier for flexible frequency planning. The multiplier also allows reduction of spurs by moving the frequencies away from the integer boundary.

The PLL is fractional-N PLL with programmable delta-sigma modulator up to 4<sup>th</sup> order. The fractional denominator is a programmable 32-bit long, which can provide fine frequency steps easily below 1-Hz resolution as well as be used to do exact fractions like 1/3, 7/1000, and many others. The phase frequency detector goes up to 300 MHz in fractional mode or 400 MHz in integer mode, although minimum N divider values must also be taken into account.

For applications where deterministic or adjustable phase is desired, the SYNC pin can be used to get the phase relationship between the OSCin and RFout pins deterministic. Once this is done, the phase can be adjusted in very fine steps of the VCO period divided by the fractional denominator.

The ultra-fast VCO calibration is ideal for applications where the frequency must be swept or abruptly changed. The frequency can be manually programmed, or the device can be set up to do ramps and chirps.

The JESD204B support includes using the RFoutB output to create a differential SYSREF output that can be either a single pulse or a series of pulses that occur at a programmable distance away from the rising edges of the output signal.

The LMX2594 device requires only a single 3.3 V power supply. The internal power supplies are provided by integrated LDOs, eliminating the need for high performance external LDOs.

The digital logic for the SPI interface and is compatible with voltage levels from 1.8 to 3.3 V.

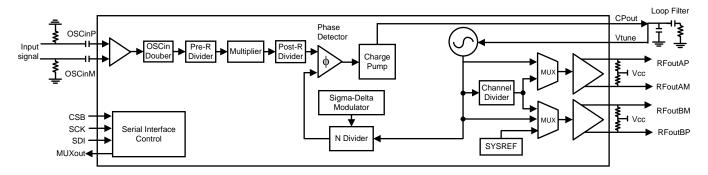
Table 1 shows the range of several of the dividers, multipliers, and fractional settings.

Table 1. Range of Dividers, Multipliers, and Fractional Settings

| PARAMETER                            | MIN              | MAX                              | COMMENTS   |
|--------------------------------------|------------------|----------------------------------|--|
| Outputs enabled                      | 0                | 2                                |  |
| OSCin doubler                        | 0 (1X)           | 1 (2X)                           | The low noise doubler can be used to increase the phase detector frequency to improve phase noise and avoid spurs. This is in reference to the OSC_2X bit. |
| Pre-R divider                        | 1 (bypass)       | 128                              | Only use the Pre R divider if the multiplier is used and the input frequency is too high for the multiplier.   |
| Multiplier                           | 3                | 7                                | This is in reference to the MULT word.   |
| Post-R divider                       | 1 (bypass)       | 255                              | The maximum input frequency for the post-R divider is 250 MHz. Use the Pre R divider if necessary.   |
| N divider                            | ≥ 28             | 524287                           | The minimum divide depends on modulator order and VCO frequency. See <i>N Divider and Fractional Circuitry</i> for more details.                           |
| Fractional numerator/<br>denominator | 1 (Integer mode) | 2 <sup>32</sup> – 1 = 4294967295 | The fractional denominator is programmable and can assume any value between 1 and 2 <sup>32</sup> –1; it is not a fixed denominator.                       |
| Fractional order                     | 0                | 4                                | Order 0 is integer mode and the order can be programmed  |
| Channel divider                      | 1 (bypass)       | 768                              | This is the series of several dividers. Also, be aware that above 10 GHz, the maximum allowable channel divider value is 6.                                |
| Output frequency                     | 10 MHz           | 15 GHz                           | This is implied by the minimum VCO frequency divided by the maximum channel divider value.   |

# TEXAS INSTRUMENTS

## 7.2 Functional Block Diagram



# 7.3 Feature Description

#### 7.3.1 Reference Oscillator Input

The OSCin pins are used as a frequency reference input to the device. The input is high impedance and requires AC-coupling caps at the pin. The OSCin pins can be driven single-ended with a CMOS clock or XO. Differential clock input is also supported, making it easier to interface with high-performance system clock devices such as TI's LMK series clock devices. As the OSCin signal is used as a clock for the VCO calibration, a proper reference signal must be applied at the OSCin pin at the time of programming FCAL\_EN.

#### 7.3.2 Reference Path

The reference path consists of an OSCin doubler (OSC\_2X), Pre-R divider, multiplier (MULT) and a Post-R divider.

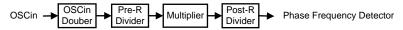


Figure 17. Reference Path Diagram

The OSCin doubler (OSC\_2X) can double up low OSCin frequencies. Pre-R (PLL\_R\_PRE) and Post-R (PLL\_R) dividers both divide frequency down while the multiplier (MULT) multiplies frequency up. The purposes of adding a multiplier is to reduce integer boundary spurs or to increase the phase detector frequency. Note that the multiplier cannot be used if the OSCin doubler is used. The phase detector frequency, f<sub>PD</sub>, is calculated as follows:

$$f_{PD} = f_{OSC} \times OSC_2X \times MULT / (PLL_R_PRE \times PLL_R)$$
 (1)



## **Feature Description (continued)**

### 7.3.2.1 OSCin Doubler (OSC\_2X)

The OSCin doubler allows one to double the input reference frequency up to 400 MHz. This doubler adds minimal noise and is useful for raising the phase detector frequency for better phase noise and also to avoid spurs. When the phase-detector frequency is increased, the flat portion of the PLL phase noise improves.

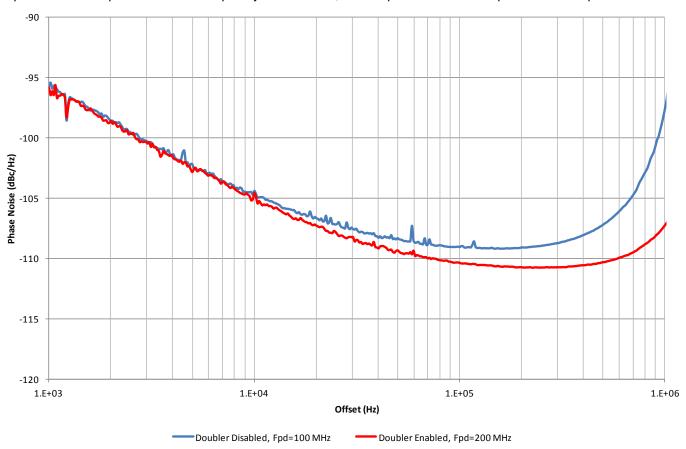


Figure 18. Benefit of Using the OSC 2X Doubler at 14 GHz

# 7.3.2.2 Pre-R Divider (PLL\_R\_PRE)

The pre-R divider is useful for reducing the input frequency so that the programmable multiplier (MULT) can be used or to help meet the maximum 250 MHz input frequency limitation to the PLL-R divider. Otherwise, it does not have to be used.

# 7.3.2.3 Programmable Multiplier (MULT)

The MULT is useful for shifting the phase-detector frequency to avoid integer boundary spurs. The multiplier allows a multiplication of 3, 4, 5, 6, or 7. Be aware that unlike the doubler, the programmable multiplier degrades the PLL figure of merit; however, this only would matter for a clean reference and if the loop bandwidth was wide.

# 7.3.2.4 Post-R Divider (PLL\_R)

The post-R divider can be used to further divide down the frequency to the phase detector frequency. When it is used (PLL\_R > 1), the input frequency to this divider is limited to 250 MHz.

# TEXAS INSTRUMENTS

# **Feature Description (continued)**

#### 7.3.3 PLL Phase Detector and Charge Pump

The phase detector compares the outputs of the Post-R divider and N divider and generates a correction current corresponding to the phase error until the two signals are aligned in phase. This charge-pump current is software programmable to many different levels, allowing modification of the closed loop bandwidth of the PLL. See application section on phase noise due to the charge pump.

### 7.3.4 N Divider and Fractional Circuitry

The N divider includes fractional compensation and can achieve any fractional denominator from 1 to  $(2^{32}-1)$ . The integer portion of N is the whole part of the N divider value, and the fractional portion,  $N_{frac} = NUM / DEN$ , is the remaining fraction. In general, the total N divider value is determined by N + NUM / DEN. The N, NUM and DEN are software programmable. The higher the denominator, the finer the resolution step of the output. For example, even when using  $f_{PD} = 200$  MHz, the output can increment in steps of 200 MHz /  $2^{32} = 0.047$  Hz. Equation 2 shows the relationship between the phase detector and VCO frequencies. Note that in SYNC mode, there is an extra divider that is not shown in Equation 2.

$$f_{VCO} = f_{pd} \times \left(N + \frac{NUM}{DEN}\right)$$
 (2)

The sigma-delta modulator that controls this fractional division is also programmable from integer mode to fourth order. To make the fractional spurs consistent, the modulator is reset any time that the R0 register is programmed.

The N divider has minimum value restrictions based on the modulator order and VCO frequency. Furthermore, the PFD\_DLY\_SEL bit must be programmed in accordance to the Table 2.

| FRAC_ORDER | f <sub>VCO</sub> (MHz) | MINIMUM N | PFD_DLY_SEL |
|------------|------------------------|-----------|-------------|
| 0          | ≤ 12500                | 28        | 1           |
|            | > 12500                | 32        | 2           |
| 1          | ≤ 10000                | 28        | 1           |
|            | 10000-12500            | 32        | 2           |
|            | >12250                 | 36        | 3           |
| 2          | ≤ 10000                | 32        | 2           |
|            | >10000                 | 36        | 3           |
| 3          | ≤ 10000                | 36        | 3           |
|            | >10000                 | 40        | 4           |
| 4          | ≤ 10000                | 44        | 5           |
|            | >10000                 | 48        | 6           |

Table 2. Minimum N Divider Restrictions

#### 7.3.5 MUXout Pin

The MUXout pin can be used to readback programmable states of the device or for lock detect.

**Table 3. MUXout Pin Configurations** 

| MUXOUT_SEL | FUNCTION    |  |
|------------|-------------|--|
| 0          | Readback    |  |
| 1          | Lock Detect |  |



# 7.3.5.1 Lock Detect

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The MUXout pin can be configured for lock detect done in by reading back the rb\_LD\_VTUNE field or using the pin as shown in the Table 4.

Table 4. Configuring the MUXout Pin for Lock Detect

| FIELD    | PROGRAMMING                             | DESCRIPTION  |
|----------|---|--|
| LD_TYPE  | 0 = VCO Calibration Status<br>1 = Vtune | This determines if the lock detect is based on the VCO tuning voltage or at the VCO calibration.   |
| LD_DLY   | 0 to 65535                              | Only valid for Vtune lock detect. This is a delay in state machine cycles. The state machine clock frequency is equal to f <sub>OSC</sub> /CAL_CLK_DIV |
| OUT_MUTE | 0 = Disabled<br>1 = Enabled             | Turns off outputs when lock detect is low.   |

VCO calibration status lock detect works by indicating a low signal whenever the VCO is calibrating or the LD\_DLY counter is running.

Vtune lock detect works by checking the Vtune voltage. Whenever the Vtune voltage is within an acceptable range and the VCO is not calibrating, then Vtune lock detect is high.

#### 7.3.5.2 Readback

The MUXout pin can be configured for to read back useful information from the device. Common uses for readback are:

- 1. Read back registers to ensure that they have been programmed to the correct value.
- 2. Read back the lock detect status to determine if the PLL is in lock.
- 3. Read back VCO calibration information so that it can be used to improve the lock time.
- 4. Read back information to help troubleshoot.

VCO calibration status lock detect works by indicating a low signal whenever the VCO is calibrating or the LD\_DLY counter is running. The delay from the LD\_DLY added to the true VCO calibration time ( $t_{VCOCAL}$ ) so it can be used to account for the analog lock time of the PLL.

Vtune lock detect works by checking the Vtune voltage. Whenever the Vtune voltage is within an acceptable range and the VCO is not calibrating, then Vtune lock detect is high.

#### 7.3.6 VCO (Voltage Controlled Oscillator)

The LMX2594 includes a fully integrated VCO. The VCO takes the voltage from the loop filter and converts this into a frequency. The VCO frequency is related to the other frequencies and as follows:

$$f_{VCO} = f_{PD} \times N \text{ divider}$$
 (3)

#### 7.3.6.1 VCO Calibration

To reduce the VCO tuning gain and therefore improve the VCO phase-noise performance, the VCO frequency range is divided into several different frequency bands. The entire range, 7.5 to 15 GHz, covers an octave that allows the divider to take care of frequencies below the lower bound. This creates the need for frequency calibration to determine the correct frequency band given a desired output frequency. The frequency calibration routine is activated any time that the R0 register is programmed with the FCAL\_EN = 1. It is important that a valid OSCin signal must present before VCO calibration begins.

The VCO also has an internal amplitude calibration algorithm to optimize the phase noise which is also activated any time the R0 register is programmed.

The optimum internal settings for this are temperature dependent. If the temperature is allowed to drift too much without being re-calibrated, some minor phase noise degradation could result. The maximum allowable drift for continuous lock,  $\Delta T_{CL}$ , is stated in the electrical specifications. For this device, a number of 125°C means the device never loses lock if the device is operated under recommended operating conditions.



The LMX2594 allows the user to assist the VCO calibration. In general, there are three kinds of assistance, as shown in Table 5:

### Table 5. Assisting the VCO Calibration Speed

| ASSISTANCE LEVEL       | DESCRIPTION  | PROGRAMMABLE SETTINGS   |
|------------------------|--|---|
| No assist              | User does nothing to improve VCO calibration speed.  | QUICK_RECAL_EN=0  |
| Partial assist         | Upon every frequency change, before the FCAL_EN bit is checked, the user provides the initial starting point for the VCO core (VCO_SEL), band (VCO_CAPCTRL_STRT), and amplitude (VCO_DACISET_STRT) based on Table 6. | QUICK_RECAL_EN=0  |
| Close Frequency Assist | Upon initialization of the device, user enables QUICK_RECAL_EN bit. The VCO uses the current VCO_CAPCTRL and VCO_AMPCAL settings as the initial starting point.  | QUICK_RECAL_EN=1  |
| Full assist            | The user forces the VCO core (VCO_SEL), amplitude settings (VCO_DACISET), and frequency band (VCO_CAPCTRL) and manually sets the value.  | VCO_SEL_FORCE=1<br>VCO_DACISET_FORCE=1<br>VCO_CAPCTRL_FORCE=1 |

To do the partial assist for the VCO calibration, follow this procedure:

1. Determine VCO Core

Find a VCO Core that includes the desired VCO frequency. If at the boundary of two cores, choose based on phase noise or performance.

2. Calculate the VCO CapCode as follows

$$VCO\_CAPCTRL\_STRT = round \; (C_{CoreMin} - (C_{CoreMin} - C_{CoreMax}) \times (f_{VCO} - f_{CoreMin}) \; / \; (f_{CoreMax} - f_{CoreMin})) \; / \; (f_{CoreMax} - f_{CoreMin}) \; / \; (f_{CoreMin} - f_{CoreMin}) \; / \; (f_$$

3. Get the AMPCal Setting from the table

$$VCO\_AMPCAL = round (A_{CoreMin} + (A_{CoreMax} - A_{CoreMin}) \times (f_{VCO} - f_{CoreMin}) / (f_{CoreMax} - f_{CoreMin}))$$

### **Table 6. VCO Core Ranges**

| VCO Core | f <sub>CoreMin</sub> | f <sub>CoreMax</sub> | C <sub>CoreMin</sub> | C <sub>CoreMax</sub> | A <sub>CoreMin</sub> | A <sub>CoreMax</sub> |
|----------|----------------------|----------------------|----------------------|----------------------|----------------------|----------------------|
| VCO 1    | 7500                 | 8600                 | 164                  | 12                   | 299                  | 240                  |
| VCO 2    | 8600                 | 9800                 | 165                  | 16                   | 356                  | 247                  |
| VCO 3    | 9800                 | 10800                | 158                  | 19                   | 324                  | 224                  |
| VCO 4    | 10800                | 12000                | 140                  | 0                    | 383                  | 244                  |
| VCO 5    | 12000                | 12900                | 183                  | 36                   | 205                  | 146                  |
| VCO 6    | 12900                | 13900                | 155                  | 6                    | 242                  | 163                  |
| VCO 7    | 13900                | 15000                | 175                  | 19                   | 323                  | 244                  |

#### **NOTE**

In the range of 11900 to 12100 MHz, VCO assistance cannot be used, and the settings must be VCO\_SEL = 4, VCO\_DACISET\_STRT = 300, and VCO\_CAPCTRL\_STRT = 1. Outside this range, in the partial assist for the VCO calibration, the VCO calibration is run. This means that if the settings are incorrect, the VCO still locks with the correct settings; the only consequence is that the calibration time might be a little longer. The closer the calibration settings are to the true final settings, the faster the VCO calibration will be.



## 7.3.6.2 Determining the VCO Gain

The VCO gain varies between the seven cores and is the lowest at the lowest end of the band and highest at the highest end of each band. For a more accurate estimation, use Table 7:

| Tab | 7 ما   | VC | $\circ$ | 2ain           |
|-----|--------|----|---------|----------------|
| 140 | IC: /. |    |         | 3 <b>4</b> 111 |

| f1    | f2    | Kvco1 | Kvco2 |
|-------|-------|-------|-------|
| 7500  | 8600  | 79    | 113   |
| 8600  | 9800  | 81    | 99    |
| 9800  | 10800 | 88    | 130   |
| 10800 | 12000 | 182   | 225   |
| 12000 | 12900 | 195   | 250   |
| 12900 | 13900 | 250   | 250   |

Based in this table, the VCO gain can be estimated for an arbitrary VCO frequency of  $f_{\text{VCO}}$  as:

$$Kvco = Kvco1 + (Kvco2-Kvco1) \times (f_{VCO} - f1) / (f2 - f1)$$
 (4)

#### 7.3.7 Channel Divider

To go below the VCO lower bound of 7.5 GHz, the channel divider can be used. The channel divider consists of four segments, and the total division value is equal to the multiplication of them. Therefore, not all values are valid.

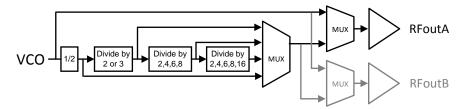


Figure 19. Channel Divider

When the channel divider is used, there are limitations on the values. Table 8 shows how these values are implemented and which segments are used.

**Table 8. Channel Divider Segments** 

| EQUIVALENT<br>DIVISION<br>VALUE | FREQUENCY<br>LIMITATION | OutMin (MHz) | OutMax (MHz) | CHDIV[4:0] | SEG0 | SEG1 | SEG2 | SEG3 |
|---------------------------------|-------------------------|--------------|--------------|------------|------|------|------|------|
| 2                               |                         | 3750         | 7500         | 0          | 2    | 1    | 1    | 1    |
| 4                               | None                    | 1875         | 3750         | 1          | 2    | 2    | 1    | 1    |
| 6                               |                         | 1250         | 2500         | 2          | 2    | 3    | 1    | 1    |

#### **Table 8. Channel Divider Segments (continued)**

| EQUIVALENT<br>DIVISION<br>VALUE | FREQUENCY<br>LIMITATION   | OutMin (MHz) | OutMax (MHz) | CHDIV[4:0] | SEG0 | SEG1 | SEG2 | SEG3 |
|---------------------------------|---------------------------|--------------|--------------|------------|------|------|------|------|
| 8                               |                           | 937.5        | 1250         | 3          | 2    | 2    | 2    | 1    |
| 12                              |                           | 625          | 833.333      | 4          | 2    | 3    | 2    | 1    |
| 16                              |                           | 468.75       | 625          | 5          | 2    | 2    | 4    | 1    |
| 24                              |                           | 312.5        | 416.667      | 6          | 2    | 2    | 6    | 1    |
| 32                              |                           | 234.375      | 312.5        | 7          | 2    | 2    | 8    | 1    |
| 48                              |                           | 125.25       | 208.333      | 8          | 2    | 3    | 8    | 1    |
| 64                              |                           | 117.1875     | 156.25       | 9          | 2    | 2    | 8    | 2    |
| 72                              | f <sub>VCO</sub> ≤ 10 GHz | 104.157      | 138.889      | 10         | 2    | 3    | 6    | 2    |
| 96                              |                           | 78.125       | 104.167      | 11         | 2    | 3    | 8    | 2    |
| 128                             |                           | 58.594       | 78.125       | 12         | 2    | 2    | 8    | 4    |
| 192                             |                           | 39.063       | 52.083       | 13         | 2    | 2    | 8    | 6    |
| 256                             |                           | 29.297       | 39.063       | 14         | 2    | 2    | 8    | 8    |
| 384                             |                           | 19.531       | 26.042       | 15         | 2    | 3    | 8    | 8    |
| 512                             |                           | 14.648       | 19.531       | 16         | 2    | 2    | 8    | 16   |
| 768                             |                           | 9.766        | 13.021       | 17         | 2    | 3    | 8    | 16   |
| Invalid                         | n/a                       | n/a          | n/a          | 18-31      | n/a  | n/a  | n/a  | n/a  |

The channel divider is powered up whenever an output (OUTx\_MUX) is selected to the channel divider or SysRef, regardless of whether it is powered down or not. When an output is not used, TI recommends selecting the VCO output to ensure that the channel divider is not unnecessarily powered up.

**Table 9. Channel Divider** 

| OUTA MUX        | OUTB MUX                  | CHANNEL DIVIDER |
|-----------------|---------------------------|-----------------|
| Channel Divider | X                         | Powered up      |
| X               | Channel Divider or SYSREF | Powered up      |
| All Othe        | Powered down              |                 |

#### 7.3.8 Output Buffer

The RF output buffer type is open collector so it requires an external pullup to Vcc. This component may be a 50- $\Omega$  resistor to give a nice 50- $\Omega$  output impedance, or an inductor. The inductor has poor output impedance, but allows higher output power. The output power can be programmed to various levels or disabled while still keeping the PLL in lock. If using a resistor, limit OUTx\_PWR setting to 40; higher than this tends to actually reduce power.

#### 7.3.9 Powerdown Modes

The LMX2594 can be powered up and down using the CE pin or the POWERDOWN bit. When the device comes out of the powered down state, either by resuming the POWERDOWN bit to zero or by pulling back CE pin HIGH (if it was powered down by CE pin), register R0 must be programmed with FCAL\_EN high again to re-calibrate the device.

### 7.3.10 Phase Synchronization

#### 7.3.10.1 General Concept

The SYNC pin allows one to synchronize the LMX2594 such that the delay from the rising edge of the OSCin signal to the output signal is deterministic. Initially, the devices are locked to the input, but are not synchronized. The user sends a synchronization pulse that is reclocked to the next rising edge of the OSCin pulse. After a given time, t<sub>1</sub>, the phase relationship from OSCin to f<sub>OUT</sub> will be deterministic. This time is dominated by the sum of the VCO calibration time, the analog setting time of the PLL loop, and the MASH\_RST\_CNT if used in fractional mode.



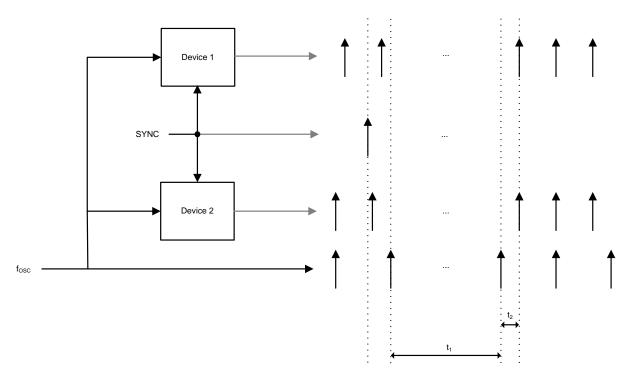


Figure 20. Devices Are Now Synchronized to OSCin Signal

When the SYNC feature is enabled, part of the channel divide is included in the feedback path.

 OUTA\_MUX / OUTB\_MUX
 CHANNEL DIVIDER
 INCLUDED DIVIDE

 Neither one has the channel divider or SysRef selected
 x
 None

 At least one is selecting the channel divider or SYSREF
 Divisible by 3, but NOT 24 or 192
 SEG0 x SEG1 = 6

 All other values
 SEG0 x SEG1 = 4

**Table 10. Included Divide** 

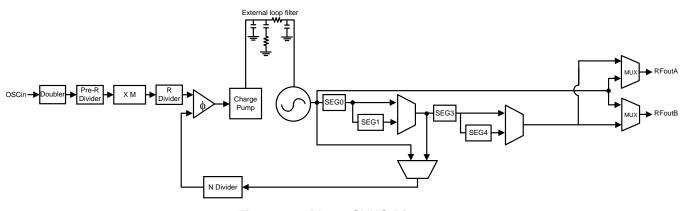


Figure 21. Phase SYNC Diagram

# 7.3.10.2 Categories of Applications for SYNC

The requirements for SYNC depend on certain setup conditions. In cases that the SYNC is not timing critical, it can be done through software by toggling the VCO\_PHASE\_SYNC bit from 0 to 1. When it is timing critical, then it must be done through the pin and the setup and hold times for the OSCin pin are critical. The Figure 22 gives the different categories.



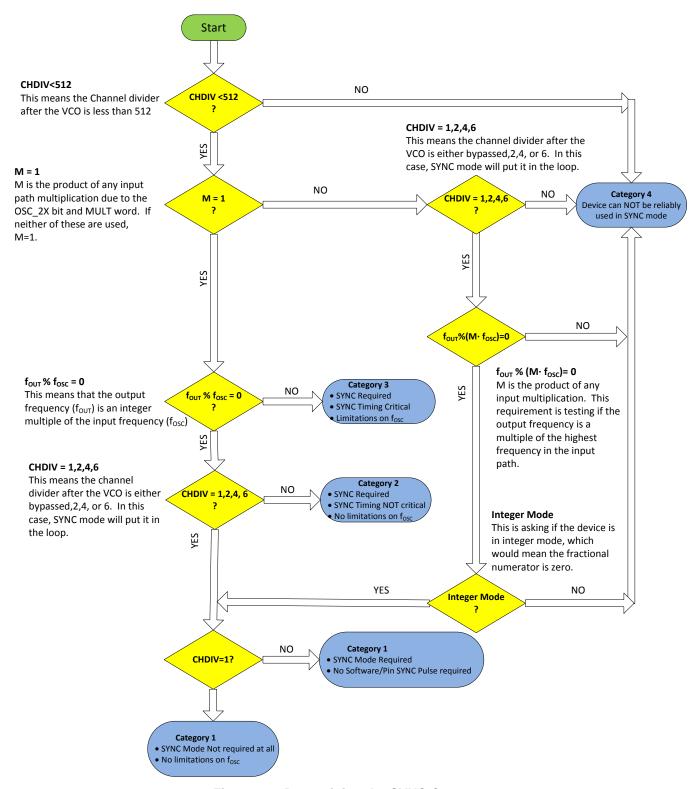


Figure 22. Determining the SYNC Category

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#### 7.3.10.3 Procedure for Using SYNC

This procedure must be used to put the device in SYNC mode.

- 1. Use the flowchart to determine the SYNC category.
- 2. Make determinations for OSCin and using SYNC based on the category
  - (a) If Category 4, SYNC cannot be performed in this setup.
  - (b) If category 3, ensure that the maximum f<sub>OSC</sub> frequency for SYNC is not violated and there are hardware accommodations to use the SYNC pin.
- 3. If the channel divide is used, determine the included channel divide value which will be 2 x SEG0 of the channel divide:
  - (a) If neither OUTA\_MUX nor OUTB\_MUX is selected to channel divider, then the included divide is one.
  - (b) If one of them is, then the included channel divide value will be  $2 \times SEGO$ .
- 4. If not done already, divide the N divider and fractional values by the included channel divide to account for the included channel divide.
- 5. Program the device with the VCO\_PHASE\_SYNC = 1. Note that this does not count as applying a SYNC to device (for category 2).
- 6. Apply the SYNC, if required
  - (a) If category 2, VCO\_PHASE\_SYNC can be toggled from 0 to 1. Alternatively, a rising edge can be sent to the SYNC pin and the timing of this is not critical.
  - (b) If category 3, the SYNC pin must be used, and the timing must be away from the rising edge of the OSCin signal.

#### 7.3.10.4 SYNC Input Pin

The SYNC input pin can be driven either in CMOS or LVDS mode. However, if not using SYNC mode (VCO\_PHASE\_SYNC = 0), then the INPIN\_IGNORE bit must be set to one, otherwise it causes issues with lock detect. If the pin is desired for to be used and VCO\_PHASE\_SYNC=1, then set INPIN\_IGNORE = 0. LVDS or CMOS mode may be used. LVDS works to 250 mVPP, but is not ensured in production.

#### 7.3.11 Phase Adjust

The LMX2594 can use the sigma-delta modulator to adjust the output signal phase with respect to the input reference. The phase shift every time you write the value of MASH SEED is:

Example:

Mash seed = 1

Denominator = 12

Channel divider = 16

Phase shift (VCO\_PHASE\_SYNC=1) =  $360 \times (1/12) \times (1/16) = 1.875$  degrees

Phase Shift (VCO\_PHASE\_SYNC=1) =  $360 \times (1/12) \times (4/16) = 7.5$  degrees

Phase shift can be done with a FRAC\_NUM=0, but FRAC\_ORDER must be greater than zero. In the case of one output being set to the VCO and the other output unused, the unused output can powered down but directed to the channel divider to put part of this in the loop, which can sometimes be used to create a fraction. For the phase adjust, the condition PLL\_DEN > PLL\_NUM + MASH\_SEED must be satisfied.

#### 7.3.12 Ramping Function

The LMX2594 supports the ability to make ramping waveforms using manual mode or automatic mode. In manual mode, the user defines a step and uses the RampClk and RampDir pins to create the ramp. In automatic mode, the user sets up the ramp with up to two linear segments in advance and the device automatically creates this ramp. Table 11 fields apply in both automatic mode and manual pin mode.

## **Table 11. Ramping Field Descriptions**

| FIELD PROGRAMMING DESCRIPTION     |   |   |  |  |  |
|-----------------------------------|---|---|--|--|--|
| TILLD                             |   |   |  |  |  |
| GENERAL COMMANDS                  |   |   |  |  |  |
| RAMP_EN                           | 0 = Disabled<br>1 = Enabled  RAMP_EN must be 1 for any ramping functions to v |   |  |  |  |
| RAMP_MANUAL                       | 0 = Automatic ramping mode<br>1 = Manual pin ramping mode                     | In automatic ramping mode, the ramping is automatic and clock is based on the phase detector. In manual pin rampin mode, the clock is based on rising edges on the RampCLk pin. |  |  |  |
| RAMPx_INC                         | 0 to 2 <sup>30</sup> – 1  | This is the amount the fractional numerator is increased for each phase detector cycle in the ramp.   |  |  |  |
| RAMPx_DLY                         | 0 to 65535  | This is the length of the ramp in phase detector cycles.  |  |  |  |
|                                   | DEALING WITH VCO CALIBRATION  |   |  |  |  |
| RAMP_THRESH                       | 0 to $\pm 2^{32}$   | Whenever the fractional numerator changes this much (either positive or negative) because the VCO was last calibrated, the VCO is forced to recalibrate.                        |  |  |  |
| RAMP_TRIG_CAL                     | 0 = Disabled<br>1 = Enabled   | When enabled, the VCO is forced to re-calibrate at the beginning each ramp. This only applies in automatic ramping mode.  |  |  |  |
| PLL_DEN                           | 4294967295  | In ramping mode, the denominator must be fixed to this forced value of $2^{32} - 1$ . However, the effective denominator in ramping mode is $2^{24}$ .                          |  |  |  |
| LD_DLY                            | 0   | This must be zero to avoid interfering with calibration.  |  |  |  |
|                                   | RAMP LIMITS   |   |  |  |  |
| RAMP_LIMIT_LOW<br>RAMP_LIMIT_HIGH | I II to 2°°   |   |  |  |  |

## **Table 12. General Restrictions for Ramping**

| RULE                        | RESTRICTION  | EXPLANATION  |
|-----------------------------|--|--|
| Phase Detector<br>Frequency | f <sub>OSC</sub> / 2 <sup>CAL_CLK_DIV</sup> ≤ f <sub>PD</sub> ≤ 125<br>MHz | Minimum Phase Detector Frequency when Ramping The phase detector frequency cannot be less than the state machine clock frequency. The state machine clock frequency is calculated from expression on the left-hand side of the inequality. This is satisfied provided there is no division in the input path. However, if the PLL R divider is used, it is necessary to adjust CAL_CLK_DIV to satisfy this constraint. Also, this implies a maximum total division in the input path of 8.  Maximum Phase Detector Frequency TI recommends that phase-detector frequency be less or equal than 125 MHz because if the phase detector frequency is too high, it can lead to distortion in the ramp. Higher phase-detector frequency frequencies may be possible, but this distortion is application specific. |

#### 7.3.12.1 Manual Pin Ramping

Manual pin ramping is enabled by setting RAMP\_EN = 1 and RAMP\_MODE = 1. In this mode, the ramp is clocked by rising edges applied to the RampCLk pin, and the RampDir pin controls the size of the change. If a rising edge is seen on the RampCLk pin while the VCO is calibrating, then this rising edge is ignored. The frequency for the RampCLK must be limited to a frequency of 250 kHz or less, and the rising edge of the RampDir signal must be targeted to the falling edge of the RampCLK pin.

Table 13. RAMP\_INC

| RampDir PIN | STEP SIZE     |
|-------------|---------------|
| Low         | Add RAMP0_INC |
| High        | Add RAMP1_INC |



### 7.3.12.1.1 Manual Pin Ramping Example

In this ramping example, assume that we want to use the pins for UP/Down control of the ramp for 10 MHz steps and the phase detector is 100 MHz.

**Table 14. Step Ramping Example** 

| FIELD         | PROGRAMMING                 | DESCRIPTION   |
|---------------|-----------------------------|---|
| RAMP_EN       | 1 = Enabled                 |   |
| RAMP_MANUAL   | 1 = Manual pin ramping mode |   |
| RAMP0_INC     | 1677722                     | (10 MHz )/ (100 MHz) × 16777216 = 1677722<br>2's complement = 1677722                       |
| RAMP1_INC     | 1072064102                  | (-10 MHz )/ (100 MHz) × 16777216 = -1677722<br>2's complement = 2^30 - 1677722 = 1072064102 |
| RAMP_TRIG_CAL | 1                           | Re-calibrate at every clock cycle   |

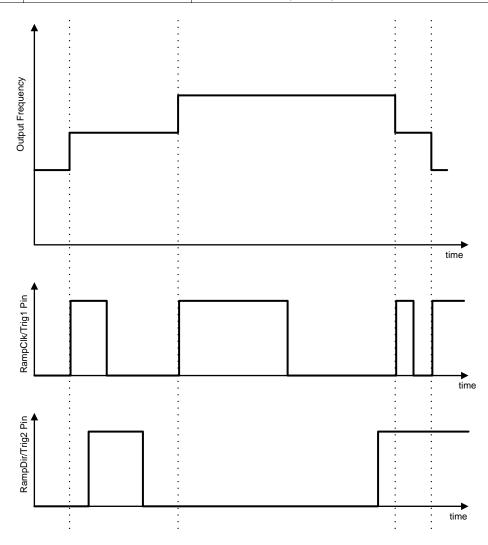


Figure 23. Step Ramping Example



#### 7.3.12.2 Automatic Ramping

Automatic ramping is enabled when RAMP\_EN=1 and RAMP\_MODE = 0. The action of programming FCAL = 1 starts the ramping. In this mode, there are two ramps that one can set the length and frequency change. In addition to this, there are ramp limits that can be used to create more complicated waveforms.

Automatic ramping can really be divided into two classes depending on if the VCO must calibrate in the middle of the ramping waveform or not. If the VCO can go the entire range without calibrating, this is calibration-free ramping, which is shown in *Typical Characteristics*. Note that this range is less at hot temperatures and for lower frequency VCOs. This range is not ensured, so margin must be built into the design.

For waveforms that are NOT calibration free, the slew rate of the ramp must be kept less than 250 kHz/µs. Also, for all automatic ramping waveforms, be aware that there is a very small phase disturbance as the VCO crosses over the integer boundary, so one might consider using the input multiplier to avoid these or timing the VCO calibrations at integer boundaries.

**Table 15. Automatic Ramping Field Descriptions** 

| FIELD                              | PROGRAMMING   | DESCRIPTION  |  |
|------------------------------------|---|--|--|
| RAMP_DLY                           | 0 = One clock cycle<br>1 = Two clock cycles   | Normally the ramp clock is equal to the phase detector frequency. When this feature is enabled, it reduces the ramp clock by a factor o 2. |  |
| RAMP0_LEN<br>RAMP1_LEN             | 0 to 65535  | This is the length of the ramp in clock cycles. Note that the time that the VCO is calibrating is added to this time.                      |  |
| RAMP0_INC<br>RAMP1_INC             | 0 to 2 <sup>30</sup>  | 2's complement of the value for the ramp increment.  |  |
| RAMP0_NEXT<br>RAMP1_NEXT           | 0 = RAMP0<br>1 = RAMP1  | Defines which ramp comes after the current ramp.   |  |
| RAMP0_NEXT_TRIG<br>RAMP1_NEXT_TRIG | 0 = Timeout counter<br>1 = Trigger A<br>2 = Trigger B<br>3 = Reserved   | Determines what triggers the action of the next ramp occurring.  |  |
| RAMP_TRIG_A<br>RAMP_TRIG_B         | 0 = Disabled 1 = RampCLk rising edge 2 = RampDir rising edge 4 = Always triggered 9 = RampCLk falling edge 10 = RampDir falling edge All other States = invalid | This field defines what the ramp trigger is.   |  |
| RAMP0_RST<br>RAMP1_RST             | 0 = Disabled<br>1 = Enabled   | Enabling this bit causes the ramp to reset to the original value when the ramping started. This is useful for roundoff errors.             |  |
| RAMP_BURST_COUNT                   | 0 to 8191   | This is the number the ramping pattern repeats and only applies for a terminating ramping pattern.   |  |
| RAMP_BURST_TRIG                    | 0 = Ramp Transition<br>1 = Trigger A<br>2 = Trigger B<br>3 = Reserved   | This defines what causes the RAMP_COUNT to increment.  |  |

### 7.3.12.2.1 Automatic Ramping Example (Triangle Wave)

Suppose user wants to generate a sawtooth ramp that goes from 8 to 10 GHz in 2 ms (including calibration breaks) with a phase-detector frequency of 50 MHz. Divide this into segments of 50 MHz where the VCO ramps for 25  $\mu$ s, then calibrates for 25  $\mu$ s, for a total of 50  $\mu$ s. There would therefore be 40 such segments which span over a 2-GHz range and would take 2 ms, including calibration time.

**Table 16. Sawtooth Ramping Example** 

| FIELD            | PROGRAMMING                | DESCRIPTION   |
|------------------|----------------------------|---|
| RAMP_EN          | 1 = Enabled                |   |
| RAMP_MANUAL      | 0 = Automatic ramping mode |   |
| RAMP_TRIG_CAL    | 0 = Disabled               |   |
| RAMP_THRESH      | 8388608                    | $50 \text{ MHz} / 50 \text{ MHz} \times 2^{24} = 16777216$  |
| RAMP_DLY         | 0 = 1 clock cycle          |   |
| RAMPx_LEN        | 13422                      | 1000 μs × 50 MHz = 50000  |
| RAMP0_INC        | 13422                      | (2000 MHz) / (50 MHz) × 2 <sup>24</sup> / 50000 = 13422   |
| RAMP1_INC        | 1073740146                 | $(-2000 \text{ MHz}) / (50 \text{ MHz}) \times 2^{24} / 50000 = -13422$<br>2's complement = $2^{30} - 13422 = 1073728402$ |
| RAMP0_NEXT       | 1 = RAMP1                  |   |
| RAMP1_NEXT       | 0 = RAMP0                  |   |
| RAMPx_NEXT_TRIG  | 0 = Timeout counter        |   |
| RAMP_TRIG_x      | 0 = Disabled               |   |
| RAMP0_RST        | 1 = Enabled                | Not necessary, but good practice to reset.  |
| RAMP1_RST        | 0 = Disabled               | Do not reset this, or ramp does not work.   |
| RAMP_BURST_COUNT | 0                          |   |
| RAMP_BURST_TRIG  | 0 = Ramp Transition        |   |

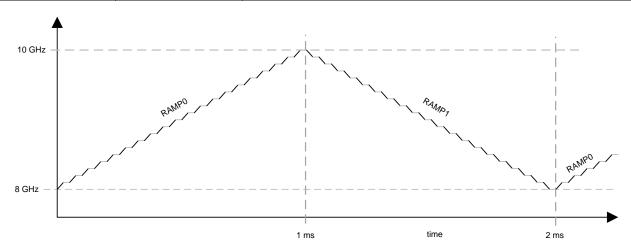


Figure 24. Triangle Waveform Example

# TEXAS INSTRUMENTS

#### 7.3.13 SYSREF

The LMX2594 can used to a SYSREF output signal that synchronized to the output with a programmable delay. This output can be a single pulse, series of pulse, or a continuous stream of pulses. To use the SYSREF capability, the PLL must be in SYNC mode with VCO PHASE SYNC = 1.

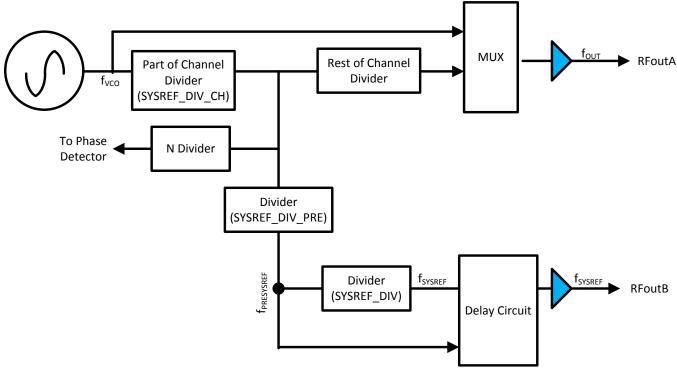


Figure 25. SYSREF Setup

As Figure 25 shows, the SYSREF feature shares parts of the channel divide and puts a pre-divider in front of the N divider; this must be taken into consideration when using the SYSREF feature.

When configured for this mode, a rising edge is sent to the SysRefReq pin, which causes the device to output either a single pulse or a series of pulses to the RFoutB pins. These pulses are synchronous with the RFoutA signal with an adjustable delay.

| 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1     |   |            |     |      |  |
|---|---|------------|-----|------|--|
| PARAMETER                                 | MIN   | TYP        | MAX | UNIT |  |
| f <sub>VCO</sub>                          | 7.5   |            | 15  | GHz  |  |
| finterpolator                             | 0.8   |            | 1.5 | GHz  |  |
| SYSREF_DIV_CH (Part of channel divider)   |   | 2, 4, or 6 |     |      |  |
| SYSREF_DIV_PRE                            | 1, 2, or 4  |            |     |      |  |
| SYSREF_DIV                                | 1 to 2047, but maybe not all values can be used                             |            |     |      |  |
| fINTERPOLATOR                             | f <sub>PRESYSREF</sub> = f <sub>VCO</sub> /(SYSREF_DIV_CH × SYSREF_DIV_PRE) |            |     |      |  |
| f <sub>SYSREF</sub>                       | f <sub>SYSREF</sub> = f <sub>INTERPOLATOR</sub> / (2 × SYSREF_DIV)          |            |     |      |  |
| Delay step size                           |   | 9          |     | ps   |  |
| Pulses for pulsed mode (SYSREF_PULSE_CNT) | 0   |            | 15  | n/a  |  |

**Table 17. SYSREF Setup** 

The delay can be programmed using the JESD\_DAC1\_CTRL, JESD\_DAC2\_CTRL, JESD\_DAC3\_CTRL, and JESD\_DAC4\_CTRL words. By concatenating these words into a larger word called "SysRefPhaseShift", the relative delay can be found. The sum of these words should always be 63.



# Table 18. SysRef Delay

| SysRef<br>DELAY | DELAY   | JESD_DAC1 | JESD_DAC2 | JESD_DAC3 | JESD_DAC4 |
|-----------------|---------|-----------|-----------|-----------|-----------|
| 0               | Minimum | 36        | 27        | 0         | 0         |
|                 |         |           |           | 0         | 0         |
| 36              |         | 0         | 63        | 0         | 0         |
| 37              |         | 62        | 1         | 0         | 0         |
|                 |         |           |           |           |           |
| 99              |         | 0         | 0         | 63        | 0         |
| 100             |         | 0         | 0         | 62        | 1         |
|                 |         |           |           |           |           |
| 161             |         | 0         | 0         | 1         | 62        |
| 162             |         | 0         | 0         | 0         | 63        |
| 163             |         | 1         | 0         | 0         | 62        |
| 224             |         | 63        | 0         | 0         | 0         |
| 225             |         | 62        | 1         | 0         | 0         |
| 247             | Maximum | 41        | 22        | 0         | 0         |
| > 247           | Invalid | Invalid   | Invalid   | Invalid   | Invalid   |

# 7.3.13.1 Programmable Fields

Table 19 has the programmable fields for the SYSREF functionality.

# **Table 19. SYSREF Programming Fields**

| FIELD            | PROGRAMMING  | DEFAULT | DESCRIPTION  |
|------------------|--|---------|--|
| SYSREF_EN        | 0 = Disabled 1 = enabled                               | 0       | Enables the SYSREF mode  |
| SYSREF_DIV_PRE   | 1: DIV1<br>2: DIV2<br>4: DIV4<br>Other states: invalid |         | The output of this divider is the f <sub>PRESYSREF</sub> .   |
| SYSREF_REPEAT    | 0 = Generator<br>1 = Repeater                          | 0       | In generator mode, the device creates a series of SYSREF pulses. In repeater mode, SYSREF pulses are generated with the SysRefReq pin. |
| SYSREF_PULSE     | 0 = Continuous mode<br>1 = Pulsed mode                 | 0       | Continuous mode continuously makes<br>SYSREF pulses, where pulsed mode makes<br>a series of SYSREF_PULSE_CNT pulses                    |
| SYSREF_PULSE_CNT | 0 to 15  | 4       | In the case of using pulsed mode, this is the number of pulses. Setting this to zero is an allowable, but not practical state.         |
| SYSREF_DIV       | 170 to 2047  | 0       | The SYSREF frequency is at the VCO frequency divided by this value.  |

SNAS696 – MARCH 2017 www.ti.com

# TEXAS INSTRUMENTS

#### 7.3.13.2 Input and Output Pin Formats

#### 7.3.13.2.1 Input Format for SYNC and SYSREF Pins

These pins are single-ended but a differential signal can be converted to drive them. In the LVDS mode, if the INPIN\_FMT is set to LVDS mode, then the bias level can be adjusted with INPIN\_LVL and the hysteresis can be adjusted with INPIN HYST.

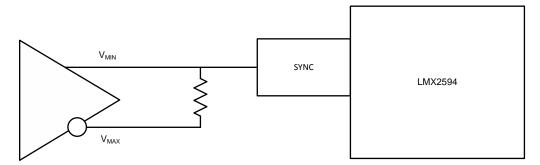


Figure 26. Driving SYNC/SYSREF with Differential Signal

#### 7.3.13.2.2 SYSREF Output Format

The SYSREF output comes in differential format through RFoutB. This will have a minimum voltage of about 2.3 V and a maximum of 3.3 V. If DC coupling cannot be used, there are two strategies for AC coupling.

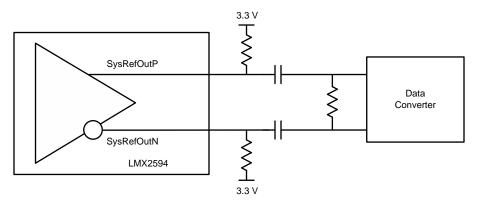


Figure 27. SYSREF Output

- 1. Send a series of pulses to establish a DC-bias level across the AC-coupling capacitor.
- 2. Establish a bias voltage at the data converter that is below the threshold voltage by using a resistive divider.

#### 7.3.13.3 Examples

The SYSREF can be used in a repeater mode, which just echos the input, after being reclocked to OSCin and then RFout, or it can be used in a repeater. In either mode, there is a phase adjustment with resolution of 1/16 of the output phase up to a maximum of 1 ns. In repeater mode, it can repeat 1,2,4,8, or infinite (continuous) pulses. The frequency for repeater mode is equal to the RFout frequency divided by the SYSREF divider.



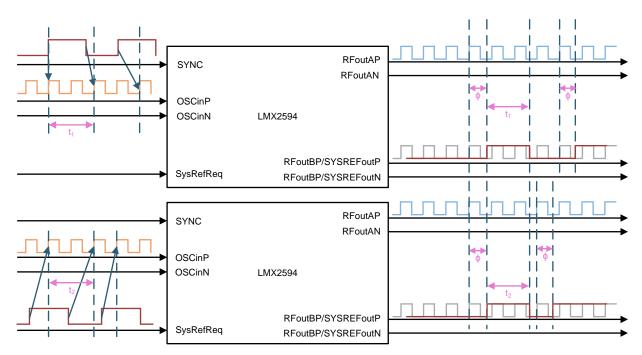


Figure 28. SYSREF Out In Repeater Mode

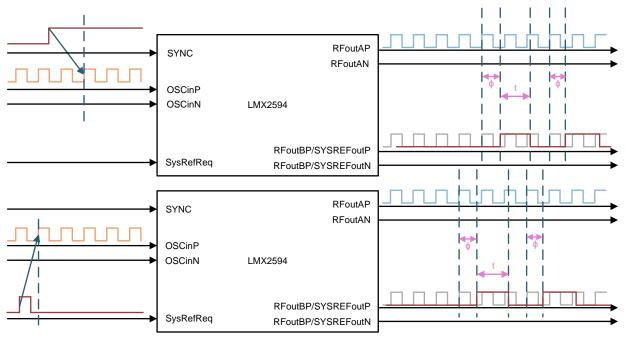


Figure 29. Figure 1. SYSREF Out In Pulsed/Continuous Mode

# TEXAS INSTRUMENTS

#### 7.3.13.4 SYSREF Procedure

To use SYSREF, do the these steps:

- 1. Put the device in SYNC mode using the procedure already outlined.
- 2. Figure out the included channel divide the same way it is done for SYNC mode.
- 3. Calculate the SYSREF\_DIV\_PRE value such that the interpolator frequency (f<sub>INTERPOLATOR</sub>) is in the range of 800 to 1500 MHz. f<sub>INTERPOLATOR</sub> = f<sub>VCO</sub>/IncludedDivide/SYSREF\_DIV\_PRE
- 4. If using master mode (SYSREF\_REPEAT=0), ensure SysRefReq pin is high, ensure the SysRefReq pin is high.
- 5. If using repeater mode (SYSREF\_REPEAT=1), set up the pulse count if desired. Pulses are created by toggling the SysRefReq pin.
- 6. Adjust the delay between the RFoutA and RFoutB signal using the JESD\_DACx\_CTL fields.

#### 7.3.14 SysRefReg Pin

The SysRefReq pin can be used in CMOS all the time, or LVDS mode is also optional if SYSREF\_REPEAT = 1. LVDS mode cannot be used in master mode.

#### 7.4 Device Functional Modes

Although there is a vast number of ways to configure this device, there is really only one functional.

**Table 20. Device Functional Modes** 

| MODE                  | DESCRIPTION  | SOFTWARE SETTINGS                   |
|-----------------------|--|-------------------------------------|
| RESET                 | Registers are held in their reset state. This device does have a power on reset, but it is good practice to also do a software reset if there is any possibility of noise on the programming lines, especially if there is sharing with other devices. Also realize that there are registers not disclosed in the data sheet that are reset as well. | RESET = 1, POWERDOWN = 0            |
| POWERDOWN             | Device is powered down.  | POWERDOWN = 1<br>or CE Pin = Low    |
| Normal operating mode | This is used with at least one output on as a frequency synthesizer.   |                                     |
| SYNC mode             | This is used where part of the channel divider is in the feedback path to ensure deterministic phase.  | VCO_PHASE_SYNC = 1                  |
| SYSREF mode           | In this mode, RFoutB is used to generate pulses for SYSREF.  | VCO_PHASE_SYNC =1,<br>SYSREF_EN = 1 |



#### 7.5 Programming

The LMX2594 is programmed using 24-bit shift registers. The shift register consists of a R/W bit (MSB), followed by a 7-bit address field and a 16-bit data field. For the R/W bit, 0 is for write, and 1 is for read. The address field ADDRESS[6:0] is used to decode the internal register address. The remaining 16 bits form the data field DATA[15:0]. While CSB is low, serial data is clocked into the shift register upon the rising edge of clock (data is programmed MSB first). When CSB goes high, data is transferred from the data field into the selected register bank. See Figure 1 for timing details.

#### 7.5.1 Recommended Initial Power-Up Sequence

For the most reliable programming, TI recommends this procedure:

- 1. Apply power to device.
- 2. Program RESET = 1 to reset registers.
- 3. Program RESET = 0 to remove reset.
- 4. Program registers as shown in the register map in REVERSE order from highest to lowest.
- 5. Program register R0 one additional time with FCAL\_EN = 1 to ensure that the VCO calibration runs from a stable state.

#### 7.5.2 Recommended Sequence for Changing Frequencies

The recommended sequence for changing frequencies is as follows:

- 1. Change the N divider value.
- 2. Program the PLL numerator and denominator.
- 3. Program  $FCAL_EN(R0[3]) = 1$ .

#### 7.6 Register Maps and Descriptions

Note that for registers that have numbers, but defined programmable bits, it is necessary to program these values just as shown in the register map. Registers must be programmed from highest to lowest (R0 Last)



# Table 21. Full Register Map

| Ro   Ro   Ro   Ro   Ro   Ro   Ro   Ro  |     |     |    |    |    | 1  | 1  |    | 1  |     |                           |     | - 5    |                           |             | ı    |             |            | 1      | 1            |       |        |             |           |                   |
|--|-----|-----|----|----|----|----|----|----|----|-----|---------------------------|-----|--------|---------------------------|-------------|------|-------------|------------|--------|--------------|-------|--------|-------------|-----------|-------------------|
| R1   |     | R/W | A6 | A5 | A4 | A3 | A2 | A1 | A0 | D15 | D14                       | D13 | D12    | D11                       | D10         | D9   | D8          | D7         | D6     | D5           | D4    | D3     | D2          | D1        | D0                |
| R2   | R0  | 0   | 0  | 0  | 0  | 0  | 0  | 0  | 0  |     | _PH<br>ASE<br>_SY<br>NC_  | 1   | 0      | 0                         | 1           | _MU  | FCAL<br>D_A | HPF<br>ADJ | FCAL_A | _LPFD<br>\DJ | 1     | L      | OUT<br>_LD_ | RES<br>ET | POW<br>ERD<br>OWN |
| R3 0 0 0 0 0 0 0 0 0 0 1 0 0 0 0 0 1 1 0 0 0 0 0 0 0 0 0 0 0 0 1 0 0 0 0 0 0 1 0 0 0 0 0 0 0 1 0   | R1  | 0   | 0  | 0  | 0  | 0  | 0  | 0  | 1  | 0   | 0                         | 0   | 0      | 1                         | 0           | 0    | 0           | 0          | 0      | 0            | 0     | 1      | CA          | CLK_      | DIV               |
| R4   | R2  | 0   | 0  | 0  | 0  | 0  | 0  | 1  | 0  | 0   | 0                         | 0   | 0      | 0                         | 1           | 0    | 1           | 0          | 0      | 0            | 0     | 0      | 0           | 0         | 0                 |
| R6   | R3  | 0   | 0  | 0  | 0  | 0  | 0  | 1  | 1  | 0   | 0                         | 0   | 0      | 0                         | 1           | 1    | 0           | 0          | 1      | 0            | 0     | 0      | 0           | 1         | 0                 |
| R6   | R4  | 0   | 0  | 0  | 0  | 0  | 1  | 0  | 0  | 0   | 0                         | 0   | 0      | 1                         | 0           | 1    | 0           | 0          | 1      | 0            | 0     | 0      | 0           | 1         | 1                 |
| R8   | R5  | 0   | 0  | 0  | 0  | 0  | 1  | 0  | 1  | 0   | 0                         | 0   | 0      | 0                         | 0           | 0    | 0           | 1          | 1      | 0            | 0     | 1      | 0           | 0         | 0                 |
| R8   | R6  | 0   | 0  | 0  | 0  | 0  | 1  | 1  | 0  | 1   | 1                         | 0   | 0      | 1                         | 0           | 0    | 0           | 0          | 0      | 0            | 0     | 0      | 0           | 1         | 0                 |
| R8   | R7  | 0   | 0  | 0  | 0  | 0  | 1  | 1  | 1  | 0   | _FO                       | 0   | 0      | 0                         | 0           | 0    | 0           | 1          | 0      | 1            | 1     | 0      | 0           | 1         | 0                 |
| R10  | R8  | 0   | 0  | 0  | 0  | 1  | 0  | 0  | 0  | 0   | _DA<br>CISE<br>T_F<br>ORC | 1   | 0      | _CA<br>PCT<br>RL_F<br>ORC | 0           | 0    | 0           | 0          | 0      | 0            | 0     | 0      | 0           | 0         | 0                 |
| R11 0 0 0 0 0 1 0 1 1 0 1 1 0 0 0 0 0 0  | R9  | 0   | 0  | 0  | 0  | 1  | 0  | 0  | 1  | 0   | 0                         | 0   |        | 0                         | 1           | 1    | 0           | 0          | 0      | 0            | 0     | 0      | 1           | 0         | 0                 |
| R12  | R10 | 0   | 0  | 0  | 0  | 1  | 0  | 1  | 0  | 0   | 0                         | 0   | 1      |                           |             | MULT |             |            | 1      | 0            | 1     | 1      | 0           | 0         | 0                 |
| R13 0 0 0 0 0 1 1 0 0 1 0 0 0 0 0 0 0 0 0  | R11 | 0   | 0  | 0  | 0  | 1  | 0  | 1  | 1  | 0   | 0                         | 0   | 0      |                           |             |      | PLI         | L_R        |        |              |       | 1      | 0           | 0         | 0                 |
| R14 0 0 0 0 0 1 1 1 1 0 0 0 0 0 1 1 1 1 1  | R12 | 0   | 0  | 0  | 0  | 1  | 1  | 0  | 0  | 0   | 1                         | 0   | 1      |                           |             | 1    |             |            | PLL_F  | R_PRE        |       |        |             |           |                   |
| R15 0 0 0 0 0 1 1 1 1 1 0 0 0 0 0 0 1 1 0 0 0 0 0 0 0 0 1 1 0 0 0 1  | R13 | 0   | 0  | 0  | 0  | 1  | 1  | 0  | 1  | 0   | 1                         | 0   | 0      | 0                         | 0           | 0    | 0           | 0          | 0      |              | 0     | 0      | 0           | 0         | 0                 |
| R16 0 0 0 1 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0  | R14 | 0   | 0  | 0  | 0  | 1  | 1  | 1  | 0  | 0   | 0                         | 0   | 1      | 1                         | 1           | 1    | 0           | 0          |        | CPG          | ı     | 0      | 0           | 0         | 0                 |
| R17         0         0         0         1         0          | R15 | 0   | 0  | 0  | 0  | 1  | 1  | 1  | 1  | 0   | 0                         | 0   | 0      | 0                         | 1           | 1    | 0           | 0          | 1      |              |       |        | 1           | 1         | 1                 |
| R18 0 0 0 1 0 0 1 0 0 0 0 0 0 0 0 0 0 0 0  | R16 | 0   | 0  | 0  | 1  | 0  | 0  | 0  | 0  | 0   | 0                         | 0   | 0      | 0                         | 0           | 0    |             |            |        |              |       |        |             |           |                   |
| R19 0 0 0 1 0 0 1 1 0 0 1 1 0 0 1 1 0 0 1 1 0 0 0 1 1 0 0 0 1 0  | R17 | 0   | 0  | 0  | 1  | 0  | 0  | 0  | 1  | 0   | 0                         | 0   | 0      | 0                         | 0           | 0    |             | 1          | ,      | VCO_D        | ACISE | T_STR1 | Γ           | 1         |                   |
| R20         0         0         1         0         1         0         1         0         VCO_SEL         VCO_SEL<br>FO RCE         VCO ORCE         0         0         0         1         0 | R18 | 0   | 0  | 0  | 1  | 0  | 0  | 1  | 0  | 0   | 0                         | 0   | 0      | 0                         | 0           | 0    | 0           | 0          | 1      | •            |       |        | L .         | 0         | 0                 |
| R20       0       0       0       1       0       0       1       0       0       1       0  | R19 | 0   | 0  | 0  | 1  | 0  | 0  | 1  | 1  | 0   | 0                         | 1   | 0      | 0                         |             | 1    | 1           |            |        | ١            | /CO_C | APCTR  | L           | 1         |                   |
|  | R20 | 0   | 0  | 0  | 1  | 0  | 1  | 0  | 0  | 1   | 0                         | ١   | /CO_SE | ĒL                        | _SEL<br>_FO | 0    | 0           | 0          | 1      | 0            | 0     | 1      | 0           | 0         | 0                 |
| R22 0 0 0 1 0 1 1 0 0 0 0 0 0 0 0 0 0 0 0  | R21 | 0   | 0  | 0  | 1  | 0  | 1  | 0  | 1  | 0   | 0                         | 0   | 0      | 0                         | 1           | 0    | 0           | 0          | 0      | 0            | 0     | 0      | 0           | 0         | 1                 |
|  | R22 | 0   | 0  | 0  | 1  | 0  | 1  | 1  | 0  | 0   | 0                         | 0   | 0      | 0                         | 0           | 0    | 0           | 0          | 0      | 0            | 0     | 0      | 0           | 0         | 1                 |

# Table 21. Full Register Map (continued)

|     | R/W | A6 | A5 | A4 | А3 | A2 | A1 | Α0 | D15              | D14 | D13 | D12  | D11   | D10    | D9               | D8     | D7              | D6              | D5                       | D4 | D3   | D2   | D1      | D0   |
|-----|-----|----|----|----|----|----|----|----|------------------|-----|-----|------|-------|--------|------------------|--------|-----------------|-----------------|--------------------------|----|------|------|---------|------|
| R23 | 0   | 0  | 0  | 1  | 0  | 1  | 1  | 1  | 0                | 0   | 0   | 0    | 0     | 0      | 0                | 0      | 0               | 1               | 1                        | 1  | 1    | 1    | 0       | 0    |
| R24 | 0   | 0  | 0  | 1  | 1  | 0  | 0  | 0  | 0                | 0   | 0   | 0    | 0     | 1      | 1                | 1      | 0               | 0               | 0                        | 1  | 1    | 0    | 1       | 0    |
| R25 | 0   | 0  | 0  | 1  | 1  | 0  | 0  | 1  | 0                | 0   | 0   | 0    | 0     | 1      | 1                | 0      | 0               | 0               | 1                        | 0  | 0    | 1    | 0       | 0    |
| R26 | 0   | 0  | 0  | 1  | 1  | 0  | 1  | 0  | 0                | 0   | 0   | 0    | 1     | 1      | 0                | 1      | 1               | 0               | 1                        | 1  | 0    | 0    | 0       | 0    |
| R27 | 0   | 0  | 0  | 1  | 1  | 0  | 1  | 1  | 0                | 0   | 0   | 0    | 0     | 0      | 0                | 0      | 0               | 0               | 0                        | 0  | 0    | 0    | 1       | 0    |
| R28 | 0   | 0  | 0  | 1  | 1  | 1  | 0  | 0  | 0                | 0   | 0   | 0    | 0     | 1      | 0                | 0      | 1               | 0               | 0                        | 0  | 1    | 0    | 0       | 0    |
| R29 | 0   | 0  | 0  | 1  | 1  | 1  | 0  | 1  | 0                | 0   | 1   | 1    | 0     | 0      | 0                | 1      | 1               | 0               | 0                        | 0  | 1    | 1    | 0       | 0    |
| R30 | 0   | 0  | 0  | 1  | 1  | 1  | 1  | 0  | 0                | 0   | 1   | 1    | 0     | 0      | 0                | 1      | 1               | 0               | 0                        | 0  | 1    | 1    | 0       | 0    |
| R31 | 0   | 0  | 0  | 1  | 1  | 1  | 1  | 1  | 0                | 1   | 0   | 0    | 0     | 0      | 1                | 1      | 1               | 1               | 1                        | 0  | 1    | 1    | 0       | 0    |
| R32 | 0   | 0  | 1  | 0  | 0  | 0  | 0  | 0  | 0                | 0   | 0   | 0    | 0     | 0      | 1                | 1      | 1               | 0               | 0                        | 1  | 0    | 0    | 1       | 1    |
| R33 | 0   | 0  | 1  | 0  | 0  | 0  | 0  | 1  | 0                | 0   | 0   | 1    | 1     | 1      | 1                | 0      | 0               | 0               | 1                        | 0  | 0    | 0    | 0       | 1    |
| R34 | 0   | 0  | 1  | 0  | 0  | 0  | 1  | 0  | 0                | 0   | 0   | 0    | 0     | 0      | 0                | 0      | 0               | 0               | 0                        | 0  | 0    | PL   | L_N[18: | 16]  |
| R35 | 0   | 0  | 1  | 0  | 0  | 0  | 1  | 1  | 0                | 0   | 0   | 0    | 0     | 0      | 0                | 0      | 0               | 0               | 0                        | 0  | 0    | 1    | 0       | 0    |
| R36 | 0   | 0  | 1  | 0  | 0  | 1  | 0  | 0  |                  | T   | 1   |      |       |        |                  | PLL_N  | T               | 1               |                          |    | T    | 1    | 1       |      |
| R37 | 0   | 0  | 1  | 0  | 0  | 1  | 0  | 1  | MASH_SEE<br>D_EN | 0   |     |      | PFD_D | LY_SEL | -                |        | 0               | 0               | 0                        | 0  | 0    | 1    | 0       | 0    |
| R38 | 0   | 0  | 1  | 0  | 0  | 1  | 1  | 0  |                  |     |     |      |       |        | PLL <sub>-</sub> | _DEN[3 | 1:16]           |                 |                          |    |      |      |         |      |
| R39 | 0   | 0  | 1  | 0  | 0  | 1  | 1  | 1  |                  |     |     |      |       |        | PLL              | _DEN[1 | 15:0]           |                 |                          |    |      |      |         |      |
| R40 | 0   | 0  | 1  | 0  | 1  | 0  | 0  | 0  |                  |     |     |      |       |        | MASH             | _SEED  | [31:16]         |                 |                          |    |      |      |         |      |
| R41 | 0   | 0  | 1  | 0  | 1  | 0  | 0  | 1  |                  |     |     |      |       |        | MASH             | I_SEED | 0[15:0]         |                 |                          |    |      |      |         |      |
| R42 | 0   | 0  | 1  | 0  | 1  | 0  | 1  | 0  |                  |     |     |      |       |        |                  | _NUM[3 |                 |                 |                          |    |      |      |         |      |
| R43 | 0   | 0  | 1  | 0  | 1  | 0  | 1  | 1  |                  | 1   |     |      |       |        | PLL              | _NUM[  | 15:0]           | 1               |                          |    | T    |      |         |      |
| R44 | 0   | 0  | 1  | 0  | 1  | 1  | 0  | 0  | 0                | 0   |     |      | OUTA  | _PWR   |                  |        | OUT<br>B_P<br>D | OUT<br>A_P<br>D | MAS<br>H_R<br>ESE<br>T_N | 0  | 0    | MAS  | SH_ORI  | DER  |
| R45 | 0   | 0  | 1  | 0  | 1  | 1  | 0  | 1  | 1                | 1   | 0   | OUTA | _MUX  | OUT_   | ISET             | 0      | 1               | 1               |                          |    | OUTB | _PWR |         |      |
| R46 | 0   | 0  | 1  | 0  | 1  | 1  | 1  | 0  | 0                | 0   | 0   | 0    | 0     | 1      | 1                | 1      | 1               | 1               | 1                        | 1  | 1    | 1    | OUTB    | _MUX |
| R47 | 0   | 0  | 1  | 0  | 1  | 1  | 1  | 1  | 0                | 0   | 0   | 0    | 0     | 0      | 1                | 1      | 0               | 0               | 0                        | 0  | 0    | 0    | 0       | 0    |
| R48 | 0   | 0  | 1  | 1  | 0  | 0  | 0  | 0  | 0                | 0   | 0   | 0    | 0     | 0      | 1                | 1      | 0               | 0               | 0                        | 0  | 0    | 0    | 0       | 0    |
| R49 | 0   | 0  | 1  | 1  | 0  | 0  | 0  | 1  | 0                | 1   | 0   | 0    | 0     | 0      | 0                | 1      | 1               | 0               | 0                        | 0  | 0    | 0    | 0       | 0    |
| R50 | 0   | 0  | 1  | 1  | 0  | 0  | 1  | 0  | 0                | 0   | 0   | 0    | 0     | 0      | 0                | 0      | 0               | 0               | 0                        | 0  | 0    | 0    | 0       | 0    |
| R51 | 0   | 0  | 1  | 1  | 0  | 0  | 1  | 1  | 0                | 0   | 0   | 0    | 0     | 0      | 0                | 0      | 1               | 0               | 0                        | 0  | 0    | 0    | 0       | 0    |
| R52 | 0   | 0  | 1  | 1  | 0  | 1  | 0  | 0  | 0                | 0   | 0   | 0    | 1     | 0      | 0                | 0      | 0               | 0               | 1                        | 0  | 0    | 0    | 0       | 0    |
| R53 | 0   | 0  | 1  | 1  | 0  | 1  | 0  | 1  | 0                | 0   | 0   | 0    | 0     | 0      | 0                | 0      | 0               | 0               | 0                        | 0  | 0    | 0    | 0       | 0    |



# Table 21. Full Register Map (continued)

|     |     |    |    |    |    |    |    | A0 D15 D14 D12 D12 D14 D10 D0 D0 D7 D6 D5 D4 D2 D2 D1 D0 |                    |        |       |                   |             |     |                     |        |         |        |       |                          |                   |                               |    |             |
|-----|-----|----|----|----|----|----|----|--|--------------------|--------|-------|-------------------|-------------|-----|---------------------|--------|---------|--------|-------|--------------------------|-------------------|-------------------------------|----|-------------|
|     | R/W | A6 | A5 | A4 | A3 | A2 | A1 | A0   | D15                | D14    | D13   | D12               | D11         | D10 | D9                  | D8     | D7      | D6     | D5    | D4                       | D3                | D2                            | D1 | D0          |
| R54 | 0   | 0  | 1  | 1  | 0  | 1  | 1  | 0  | 0                  | 0      | 0     | 0                 | 0           | 0   | 0                   | 0      | 0       | 0      | 0     | 0                        | 0                 | 0                             | 0  | 0           |
| R55 | 0   | 0  | 1  | 1  | 0  | 1  | 1  | 1  | 0                  | 0      | 0     | 0                 | 0           | 0   | 0                   | 0      | 0       | 0      | 0     | 0                        | 0                 | 0                             | 0  | 0           |
| R56 | 0   | 0  | 1  | 1  | 1  | 0  | 0  | 0  | 0                  | 0      | 0     | 0                 | 0           | 0   | 0                   | 0      | 0       | 0      | 0     | 0                        | 0                 | 0                             | 0  | 0           |
| R57 | 0   | 0  | 1  | 1  | 1  | 0  | 0  | 1  | 0                  | 0      | 0     | 0                 | 0           | 0   | 0                   | 0      | 0       | 0      | 1     | 0                        | 0                 | 0                             | 0  | 0           |
| R58 | 0   | 0  | 1  | 1  | 1  | 0  | 1  | 0  | 1                  | 0      | 0     | 0                 | 0           | 0   | 0                   | 0      | 0       | 0      | 0     | 0                        | 0                 | 0                             | 0  | 1           |
| R59 | 0   | 0  | 1  | 1  | 1  | 0  | 1  | 1  | 0                  | 0      | 0     | 0                 | 0           | 0   | 0                   | 0      | 0       | 0      | 0     | 0                        | 0                 | 0                             | 0  | LD_T<br>YPE |
| R60 | 0   | 0  | 1  | 1  | 1  | 1  | 0  | 0  |                    |        |       |                   |             |     | l                   | _D_DL\ | 1       |        |       |                          |                   |                               |    |             |
| R61 | 0   | 0  | 1  | 1  | 1  | 1  | 0  | 1  | 0                  | 0      | 0     | 0                 | 0           | 0   | 0                   | 0      | 1       | 0      | 1     | 0                        | 1                 | 0                             | 0  | 0           |
| R62 | 0   | 0  | 1  | 1  | 1  | 1  | 1  | 0  | 0                  | 0      | 0     | 0                 | 0           | 0   | 1                   | 1      | 0       | 0      | 1     | 0                        | 0                 | 0                             | 1  | 0           |
| R63 | 0   | 0  | 1  | 1  | 1  | 1  | 1  | 1  | 0                  | 0      | 0     | 0                 | 0           | 0   | 0                   | 0      | 0       | 0      | 0     | 0                        | 0                 | 0                             | 0  | 0           |
| R64 | 0   | 1  | 0  | 0  | 0  | 0  | 0  | 0  | 0                  | 0      | 0     | 1                 | 0           | 0   | 1                   | 1      | 1       | 0      | 0     | 0                        | 1                 | 0                             | 0  | 0           |
| R65 | 0   | 1  | 0  | 0  | 0  | 0  | 0  | 1  | 0                  | 0      | 0     | 0                 | 0           | 0   | 0                   | 0      | 0       | 0      | 0     | 0                        | 0                 | 0                             | 0  | 0           |
| R66 | 0   | 1  | 0  | 0  | 0  | 0  | 1  | 0  | 0                  | 0      | 0     | 0                 | 0           | 0   | 0                   | 1      | 1       | 1      | 1     | 1                        | 0                 | 1                             | 0  | 0           |
| R67 | 0   | 1  | 0  | 0  | 0  | 0  | 1  | 1  | 0                  | 0      | 0     | 0                 | 0           | 0   | 0 0 0 0 0 0 0 0 0 0 |        |         |        |       |                          |                   | 0                             |    |             |
| R68 | 0   | 1  | 0  | 0  | 0  | 1  | 0  | 0  | 0                  | 0      | 0     | 0                 | 0           | 0   | 1                   | 1      | 1       |        |       |                          |                   |                               |    |             |
| R69 | 0   | 1  | 0  | 0  | 0  | 1  | 0  | 1  |                    |        | •     |                   |             | MA  | SH_RS               | T_COL  | JNT[31: | 16]    |       | •                        |                   |                               |    | •           |
| R70 | 0   | 1  | 0  | 0  | 0  | 1  | 1  | 0  |                    |        |       |                   |             | M   | ASH_R               | ST_CO  | UNT[15  | :0]    |       |                          |                   |                               |    |             |
| R71 | 0   | 1  | 0  | 0  | 0  | 1  | 1  | 1  | 0                  | 0      | 0     | 0                 | 0           | 0   | 0                   | 0      | SYSR    | EF_DI\ | /_PRE | SYS<br>REF<br>_PUL<br>SE | SYS<br>REF<br>_EN | SYS<br>REF<br>_RE<br>PEA<br>T | 0  | 1           |
| R72 | 0   | 1  | 0  | 0  | 1  | 0  | 0  | 0  | 0                  | 0      | 0     | 0                 | 0           |     | •                   | •      |         | SY     | SREF_ | DIV                      |                   |                               |    | •           |
| R73 | 0   | 1  | 0  | 0  | 1  | 0  | 0  | 1  | 0                  | 0      | 0     | 0                 |             | JE  | SD_DA               | C2_CT  | RL      |        |       | JE                       | SD_DA             | C1_CT                         | RL |             |
| R74 | 0   | 1  | 0  | 0  | 1  | 0  | 1  | 0  | SYSRE              | F_PULS | SE_CN | Γ                 |             | JE  | SD_DA               | C4_CT  | RL      |        |       | JE                       | SD_DA             | C3_CT                         | RL |             |
| R75 | 0   | 1  | 0  | 0  | 1  | 0  | 1  | 1  | 0                  | 0      | 0     | 0                 | 1           |     |                     | CHDIV  |         |        | 0     | 0                        | 0                 | 0                             | 0  | 0           |
| R76 | 0   | 1  | 0  | 0  | 1  | 1  | 0  | 0  | 0                  | 0      | 0     | 0                 | 0           | 0   | 0                   | 0      | 0       | 0      | 0     | 0                        | 1                 | 1                             | 0  | 0           |
| R77 | 0   | 1  | 0  | 0  | 1  | 1  | 0  | 1  | 0                  | 0      | 0     | 0                 | 0           | 0   | 0                   | 0      |         |        |       |                          |                   |                               |    |             |
| R78 | 0   | 1  | 0  | 0  | 1  | 1  | 1  | 0  | 0                  | 0      | 0     | 0                 | SH[3   L_EN |     |                     |        |         |        |       | 1                        |                   |                               |    |             |
| R79 | 0   | 1  | 0  | 0  | 1  | 1  | 1  | 1  | RAMP_THRESH[31:16] |        |       |                   |             |     |                     |        |         |        |       |                          |                   |                               |    |             |
| R80 | 0   | 1  | 0  | 1  | 0  | 0  | 0  | 0  |                    |        |       | RAMP_THRESH[15:0] |             |     |                     |        |         |        |       |                          |                   |                               |    |             |

4 Su

#### Table 21. Full Register Map (continued)

|      |     |    |    |    |    |    |            |    | Table 21. Full Register Map (continued) |     |     |     |     |      |        |                    |         |                   |                       |                        |    |    |                  |                                     |
|------|-----|----|----|----|----|----|------------|----|---|-----|-----|-----|-----|------|--------|--------------------|---------|-------------------|-----------------------|------------------------|----|----|------------------|-------------------------------------|
|      | R/W | A6 | A5 | A4 | А3 | A2 | <b>A</b> 1 | A0 | D15                                     | D14 | D13 | D12 | D11 | D10  | D9     | D8                 | D7      | D6                | D5                    | D4                     | D3 | D2 | D1               | D0                                  |
| R81  | 0   | 1  | 0  | 1  | 0  | 0  | 0          | 1  | 0                                       | 0   | 0   | 0   | 0   | 0    | 0      | 0                  | 0       | 0                 | 0                     | 0                      | 0  | 0  | 0                | RAM<br>P_LI<br>MIT_<br>HIGH<br>[32] |
| R82  | 0   | 1  | 0  | 1  | 0  | 0  | 1          | 0  |   |     |     |     |     | R/   | AMP_L  | IMIT_HI            | GH[31:  | 16]               |                       |                        |    |    |                  |                                     |
| R83  | 0   | 1  | 0  | 1  | 0  | 0  | 1          | 1  |   |     |     |     |     | R    | AMP_L  | .IMIT_H            | IGH[15: | :0]               |                       |                        |    |    |                  |                                     |
| R84  | 0   | 1  | 0  | 1  | 0  | 1  | 0          | 0  | 0                                       | 0   | 0   | 0   | 0   | 0    | 0      | 0                  | 0       | 0                 | 0                     | 0                      | 0  | 0  | 0                | RAM<br>P_LI<br>MIT_<br>LOW<br>[32]  |
| R85  | 0   | 1  | 0  | 1  | 0  | 1  | 0          | 1  |   |     |     |     |     |      |        | IMIT_LC            |         |                   |                       |                        |    |    |                  |                                     |
| R86  | 0   | 1  | 0  | 1  | 0  | 1  | 1          | 0  |   |     | T   | 1   | Т   | R    | AMP_L  | IMIT_L             | OW[15:  | 0]                | Т                     | 1                      | T  | Т  | т                |                                     |
| R87  | 0   | 1  | 0  | 1  | 0  | 1  | 1          | 1  | 0                                       | 0   | 0   | 0   | 0   | 0    | 0      | 0                  | 0       | 0                 | 0                     | 0                      | 0  | 0  | 0                | 0                                   |
| R88  | 0   | 1  | 0  | 1  | 1  | 0  | 0          | 0  | 0                                       | 0   | 0   | 0   | 0   | 0    | 0      | 0                  | 0       | 0                 | 0                     | 0                      | 0  | 0  | 0                | 0                                   |
| R89  | 0   | 1  | 0  | 1  | 1  | 0  | 0          | 1  | 0                                       | 0   | 0   | 0   | 0   | 0    | 0      | 0                  | 0       | 0                 | 0                     | 0                      | 0  | 0  | 0                | 0                                   |
| R90  | 0   | 1  | 0  | 1  | 1  | 0  | 1          | 0  | 0                                       | 0   | 0   | 0   | 0   | 0    | 0      | 0                  | 0       | 0                 | 0                     | 0                      | 0  | 0  | 0                | 0                                   |
| R91  | 0   | 1  | 0  | 1  | 1  | 0  | 1          | 1  | 0                                       | 0   | 0   | 0   | 0   | 0    | 0      | 0                  | 0       | 0                 | 0                     | 0                      | 0  | 0  | 0                | 0                                   |
| R92  | 0   | 1  | 0  | 1  | 1  | 1  | 0          | 0  | 0                                       | 0   | 0   | 0   | 0   | 0    | 0      | 0                  | 0       | 0                 | 0                     | 0                      | 0  | 0  | 0                | 0                                   |
| R93  | 0   | 1  | 0  | 1  | 1  | 1  | 0          | 1  | 0                                       | 0   | 0   | 0   | 0   | 0    | 0      | 0                  | 0       | 0                 | 0                     | 0                      | 0  | 0  | 0                | 0                                   |
| R94  | 0   | 1  | 0  | 1  | 1  | 1  | 1          | 0  | 0                                       | 0   | 0   | 0   | 0   | 0    | 0      | 0                  | 0       | 0                 | 0                     | 0                      | 0  | 0  | 0                | 0                                   |
| R95  | 0   | 1  | 0  | 1  | 1  | 1  | 1          | 1  | 0                                       | 0   | 0   | 0   | 0   | 0    | 0      | 0                  | 0       | 0                 | 0                     | 0                      | 0  | 0  | 0                | 0                                   |
| R96  | 0   | 1  | 1  | 0  | 0  | 0  | 0          | 0  | RAMP_BUR<br>ST_EN                       |     |     |     |     | F    | RAMP_  | BURST <sub>.</sub> | _COUN   | Т                 |                       |                        |    |    | 0                | 0                                   |
| R97  | 0   | 1  | 1  | 0  | 0  | 0  | 0          | 1  | RAMP0_RS<br>T                           | 0   | 0   | 0   | 1   |      | RAMP.  | _TRIGB             |         |                   | RAMP.                 | _TRIGA                 | ı  | 0  | RAMF<br>ST_      | P_BUR<br>TRIG                       |
| R98  | 0   | 1  | 1  | 0  | 0  | 0  | 1          | 0  |   |     |     | +   | -   | RAME | P0_INC | [29:16]            |         |                   |                       |                        |    | -  | RAM<br>P0_F<br>L | RAM<br>P0_D<br>LY                   |
| R99  | 0   | 1  | 1  | 0  | 0  | 0  | 1          | 1  |   |     |     |     |     |      | RAM    | P0_INC             | [15:0]  |                   |                       |                        |    |    |                  |                                     |
| R100 | 0   | 1  | 1  | 0  | 0  | 1  | 0          | 0  |   |     |     |     |     |      | R/     | AMP0_L             | EN      |                   |                       |                        |    |    |                  |                                     |
| R101 | 0   | 1  | 1  | 0  | 0  | 1  | 0          | 1  | 0                                       | 0   | 0   | 0   | 0   | 0    | 0      | 0                  | 0       | RAM<br>P1<br>_DLY | RAM<br>P1<br>_RS<br>T | RAM<br>P0<br>_NE<br>XT | 0  | 0  | _N               | MP0<br>EXT<br>RIG                   |
| R102 | 0   | 1  | 1  | 0  | 0  | 1  | 1          | 0  | 0                                       | 0   |     |     |     |      |        | R.A                | AMP1_I  | NC[29:1           | 16]                   |                        |    |    |                  |                                     |
| R103 | 0   | 1  | 1  | 0  | 0  | 1  | 1          | 1  |   |     |     |     |     |      | RAM    | P1_INC             | [15:0]  |                   |                       |                        |    |    |                  |                                     |

46





# Table 21. Full Register Map (continued)

|      | R/W | A6 | A5 | A4 | А3 | A2 | A1 | A0 | D15                              | D14 | D13 | D12 | D11   | D10        | D9 | D8    | D7  | D6    | D5                      | D4                        | D3 | D2   | D1           | D0   |
|------|-----|----|----|----|----|----|----|----|----------------------------------|-----|-----|-----|-------|------------|----|-------|-----|-------|-------------------------|---------------------------|----|------|--------------|------|
| R104 | 0   | 1  | 1  | 0  | 1  | 0  | 0  | 0  |                                  |     |     |     |       |            | RA | MP1_L | EN  | •     |                         |                           |    |      |              |      |
| R105 | 0   | 1  | 1  | 0  | 1  | 0  | 0  | 1  |                                  |     |     | RAM | P_DLY | _CNT       |    |       |     |       | RAM<br>P_M<br>ANU<br>AL | RAM<br>P1_N<br>EXT        | 0  | 0    | RAMF<br>XT_1 |      |
| R106 | 0   | 1  | 1  | 0  | 1  | 0  | 1  | 0  | 0                                | 0   | 0   | 0   | 0     | 0          | 0  | 0     | 0   | 0     | 0                       | RAM<br>P_T<br>RIG_<br>CAL | 0  | RAMP | SCAL<br>UNT  | E_CO |
| R107 | 0   | 1  | 1  | 0  | 1  | 0  | 1  | 1  | 0                                | 0   | 0   | 0   | 0     | 0          | 0  | 0     | 0   | 0     | 0                       | 0                         | 0  | 0    | 0            | 0    |
| R108 | 0   | 1  | 1  | 0  | 1  | 1  | 0  | 0  | 0                                | 0   | 0   | 0   | 0     | 0          | 0  | 0     | 0   | 0     | 0                       | 0                         | 0  | 0    | 0            | 0    |
| R109 | 0   | 1  | 1  | 0  | 1  | 1  | 0  | 1  | 0                                | 0   | 0   | 0   | 0     | 0          | 0  | 0     | 0   | 0     | 0                       | 0                         | 0  | 0    | 0            | 0    |
| R110 | 0   | 1  | 1  | 0  | 1  | 1  | 1  | 0  | 0                                | 0   | 0   | 0   | 0     | rb_LD<br>N |    | 0     | rb_ | vco_s | SEL                     | 0                         | 0  | 0    | 0            | 0    |
| R111 | 0   | 1  | 1  | 0  | 1  | 1  | 1  | 1  | 1 0 0 0 0 0 0 0 0 rb_VCO_CAPCTRL |     |     |     |       |            |    |       |     |       |                         |                           |    |      |              |      |
| R112 | 0   | 1  | 1  | 1  | 0  | 0  | 0  | 0  |                                  |     |     |     |       |            |    |       |     |       |                         |                           |    |      |              |      |

# 7.6.1 General Registers R0, R1, & R7

# Figure 30. Registers Excluding Address

| Addre ss | D15         | D14                               | D13 | D12 | D11 | D10 | D9           | D8          | D7 | D6    | D5 | D4 | D3          | D2                        | D1        | D0                |
|----------|-------------|-----------------------------------|-----|-----|-----|-----|--------------|-------------|----|-------|----|----|-------------|---------------------------|-----------|-------------------|
| R0       | RAMP<br>_EN | VCO_<br>PHAS<br>E_SY<br>NC_E<br>N | 1   | 0   | 0   | 1   | OUT_<br>MUTE | FCAL_<br>AI |    | FCAL_ |    | 1  | FCAL<br>_EN | MUX<br>OUT_<br>LD_S<br>EL | RESE<br>T | POW<br>ERDO<br>WN |
| R1       | 0           | 0                                 | 0   | 0   | 1   | 0   | 0            | 0           | 0  | 0     | 0  | 0  | 1           | CA                        | L_CLK_I   | DIV               |
| R7       | 0           | OUT_<br>FORC<br>E                 | 0   | 0   | 0   | 0   | 0            | 0           | 1  | 0     | 1  | 1  | 0           | 0                         | 1         | 0                 |

LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

# **Table 22. Field Descriptions**

| Location | Field          | Туре | Reset | Description   |
|----------|----------------|------|-------|---|
| R0[15]   | RAMP_EN        | R/W  | 0     | Disable frequency ramping mode     Enable frequency ramping mode  |
| R0[14]   | VCO_PHASE_SYNC | R/W  | 0     | Disable phase SYNC mode     Enable phase SYNC mode  |
| R0[9]    | OUT_MUTE       | R/W  | 0     | Mute the outputs when the VCO is calibrating.  0 : Disabled. If disabled, also be sure to enable OUT_FORCE  1 : Enabled. If enabled, also be sure to disable OUT_FORCE  |
| R0[8:7]  | FCAL_HPFD_ADJ  | R/W  |       | Set this field in accordance to the phase-detector frequency for optimal VCO calibration. $0:f_{PD}\leq 100~\text{MHz}\\1:100~\text{MHz}200~\text{MHz}$   |
| R0[6:5]  | FCAL_LPFD_ADJ  | R/W  | 0     | Set this field in accordance to the phase detector frequency for optimal VCO calibration. 0: $f_{PD} \ge 10$ MHz 1: $10$ MHz > $f_{PD} \ge 5$ MHz 2: $5$ MHz > $f_{PD} \ge 2.5$ MHz 3: $f_{PD} < 2.5$ MHz                       |
| R0[3]    | FCAL_EN        | R/W  | 0     | Enablie the VCO frequency calibration. Also note that the action of programming this bit to a 1 activates the VCO calibration   |
| R0[2]    | MUXOUT_LD_SEL  | R/W  | 0     | Selects the state of the function of the MUXout pin 0: Readback 1: Lock detect  |
| R0[1]    | RESET          | R/W  | 0     | Resets and holds all state machines and registers to default value.  0: Normal operation 1: Reset   |
| R0[0]    | POWERDOWN      | R/W  | 0     | Powers down entire device 0: Normal operation 1: Powered down   |
| R1[2:0]  | CAL_CLK_DIV    | R/W  | 3     | Sets divider for VCO calibration state machine clock based on input frequency. 0: $f_{OSC} \le 200$ MHz 1: 200 MHz < $f_{OSC} \le 400$ MHz 2: 400 MHz < $f_{OSC} \le 800$ MHz 3: $f_{OSC} \ge 800$ MHz 3: $f_{OSC} \ge 800$ MHz |
| R7[14]   | OUT_FORCE      | R/W  | 0     | Works with OUT_MUTE in disabling outputs when VCO calibrating.  |



#### 7.6.2 Input Path Registers

# Figure 31. Registers excluding address

|     | D15 | D14 | D13 | D12        | D11 | D10 | D9   | D8  | D7 | D6    | D5    | D4 | D3 | D2 | D1 | D0 |
|-----|-----|-----|-----|------------|-----|-----|------|-----|----|-------|-------|----|----|----|----|----|
| R9  | 0   | 0   | 0   | OSC_<br>2X | 0   | 1   | 1    | 0   | 0  | 0     | 0     | 0  | 0  | 1  | 0  | 0  |
| R10 | 0   | 0   | 0   | 1          |     |     | MULT |     |    | 1     | 0     | 1  | 1  | 0  | 0  | 0  |
| R11 | 0   | 0   | 0   | 0          |     |     |      | PLI | _R |       |       |    | 1  | 0  | 0  | 0  |
| R12 | 0   | 1   | 0   | 1          |     |     |      |     |    | PLL_F | R_PRE |    |    |    |    |    |

LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

#### **Table 23. Field Descriptions**

| Location  | Field     | Туре | Reset | Description   |
|-----------|-----------|------|-------|---|
| R9[12]    | OSC_2X    | R/W  | 0     | Low=noise OSCin frequency doubler. 0: Disabled 1: Enabled                           |
| R10[11:7] | MULT      | R/W  | 1     | Programmable input frequency multiplier 0,2,,8-31: Reserved 1: Byapss 3: 3X 7: 7X   |
| R11[11:4] | PLL_R     | R/W  | 1     | Programmable input path divider after the programmable input frequency multiplier.  |
| R12[11:0] | PLL_R_PRE | R/W  | 1     | Programmable input path divider before the programmable input frequency multiplier. |

# 7.6.3 Charge Pump Registers (R13, R14)

# Figure 32. Registers excluding address

|     | D15 | D14 | D13 | D12 | D11 | D10 | D9 | D8 | D7 | D6 | D5  | D4 | D3 | D2 | D1 | D0 |
|-----|-----|-----|-----|-----|-----|-----|----|----|----|----|-----|----|----|----|----|----|
| R14 | 0   | 0   | 0   | 1   | 1   | 1   | 1  | 0  | 0  |    | CPG |    | 0  | 0  | 0  | 0  |

LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

# **Table 24. Field Descriptions**

| Location | Field | Туре | Reset | Description   |
|----------|-------|------|-------|---|
| R14[6:4] | CPG   | R/W  | 7     | Effective charge-pump current. This is the sum of up and down currents. 0: 0 mA 1: 6 mA 2: Reserved 3: 12 mA 4: 3 mA 5: 9 mA 6: Reserved 7: 15 mA |



# 7.6.4 VCO Calibration Registers

# Figure 33. Registers Excluding Address

|     | D15 | D14                               | D13 | D12    | D11                               | D10                       | D9 | D8 | D7 | D6                           | D5    | D4     | D3    | D2     | D1 | D0 |
|-----|-----|-----------------------------------|-----|--------|-----------------------------------|---------------------------|----|----|----|------------------------------|-------|--------|-------|--------|----|----|
| R8  | 0   | VCO_<br>DACI<br>SET_<br>FORC<br>E | 1   | 0      | VCO_<br>CAPC<br>TRL_<br>FORC<br>E | 0                         | 0  | 0  | 0  | 0                            | 0     | 0      | 0     | 0      | 0  | 0  |
| R16 | 0   | 0                                 | 0   | 0      | 0                                 | 0                         | 0  |    |    |                              | VCO_D | ACISET |       |        |    |    |
| R17 | 0   | 0                                 |     | 0      |                                   | 0                         | 0  | 0  | 0  | VCO_<br>DACI<br>SET_<br>STRT | 0     | 0      | 1     | 1      | 0  | 0  |
| R19 | 0   | 0                                 |     | 1      |                                   | 0                         | 0  | 1  | 1  | 1                            |       |        | VCO_C | APCTRL |    |    |
| R20 | 1   | VCO_<br>SEL_<br>STRT<br>_EN       | \   | /CO_SE | L                                 | VCO_<br>SEL_<br>FORC<br>E | 0  | 0  | 0  | 1                            | 0     | 0      | 1     | 0      | 0  | 0  |

LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

# **Table 25. Field Descriptions**

| Location   | Field             | Туре | Reset | Description   |
|------------|-------------------|------|-------|---|
| R8[14]     | VCO_DACISET_FORCE | R/W  | 0     | This forces the VCO_DACISET value   |
| R8[11]     | VCO_CAPCTRL_FORCE | R/W  | 0     | This forces the VCO_CAPCTRL value   |
| R16[8:0]   | VCO_DACISET       | R/W  | 128   | This sets the final amplitude for the VCO calibration in the case that amplitude calibration is forced.   |
| R17[8:0]   | VCO_DACISET_STRT  | R/W  | 250   | This sets the initial starting point for the VCO amplitude calibration.   |
| R19[7:0]   | VCO_CAPCTRL       | R/W  | 183   | This sets the final VCO band when VCO_CAPCTRL is forced.  |
| R20[13:11] | VCO_SEL           | R/W  | 7     | This sets the VCO that is used when VCO_SEL_STRT_EN=1 or VCO_SEL_FORCE=1 0: Not Used 1: VCO1 2: VCO2 3: VCO3 4: VCO4 5: VCO5 6: VCO6 7: VCO7    |
| R20[10]    | VCO_SEL_FORCE     | R/W  | 0     | This forces the VCO to use the core specified by VCO_SEL. It is intended mainly for diagnostic purposes.  0: Disabled (recommended)  1: Enabled |

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# 7.6.5 N Divider, MASH, and Output Registers

# Figure 34. Registers Excluding Address

|     | D15   | D14 | D13 | D12 | D11    | D10    | D9   | D8      | D7       | D6 | D5 | D4 | D3 | D2  | D1       | D0   |
|-----|---|-----|-----|-----|--------|--------|------|---------|----------|----|----|----|----|-----|----------|------|
| R34 | 0   | 0   | 0   | 0   | 0      | 0      | 0    | 0       | 0        | 0  | 0  | 0  | 0  | PL  | .L_N[18: | 16]  |
| R36 |   |     |     |     |        |        |      | PLI     | N        |    |    |    |    |     |          |      |
| R37 | MASH<br>_SEE<br>D_EN                          | 0   |     |     | PFD_DI | LY_SEL |      |         | 0        | 0  | 0  | 0  | 0  | 1   | 0        | 0    |
| R38 | PLL_DEN[31:16]                                |     |     |     |        |        |      |         |          |    |    |    |    |     |          |      |
| R39 | PLL_DEN[15:0]                                 |     |     |     |        |        |      |         |          |    |    |    |    |     |          |      |
| R40 | MASH_SEED[31:16]                              |     |     |     |        |        |      |         |          |    |    |    |    |     |          |      |
| R41 |   |     |     |     |        |        | N    | /ASH_SI | EED[15:0 | 0] |    |    |    |     |          |      |
| R42 |   |     |     |     |        |        |      | PLL_NU  | M[31:16] |    |    |    |    |     |          |      |
| R43 |   |     |     |     |        |        |      | PLL_NU  | JM[15:0] |    |    |    |    |     |          |      |
| R44 | 0 0 OUTA_PWR OUTA OUTA ARES O MASH_ORDER ET_N |     |     |     |        |        |      |         |          |    |    |    |    | DER |          |      |
| R45 | 1   | 0   | 1   | 1   |        |        | OUTB | _PWR    |          |    |    |    |    |     |          |      |
| R46 | 6 0 0 0 0 0 1 1                               |     |     |     |        |        |      |         | 1        | 1  | 1  | 1  | 1  | 1   | OUTB     | _MUX |

LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

#### **Table 26. Field Descriptions**

|                        |   |      | ZO. FIEIU D   |   |
|------------------------|---|------|---|---|
| Location               | Field   | Туре | Reset   | Description   |
| R34[2:0]<br>R36[15:0]  | PLL_N   | R/W  | 100   | The PLL_N divider value is in the feedback path and divides the VCO frequency. 0: Disabled 1: Enabled   |
| R37[15]                | MASH_SEED_EN  | R/W  | 0   | Enabling this bit allows the MASH_SEED to be applied to shift the phase at the output or optimize spurs.  |
| R37[13:8]              | PFD_DLY_SEL   | R/W  | 2   | The PFD_DLY_SEL must be adjusted in accordance to the N divider value. This is with the functional description for the N divider.                       |
| R38[15:0]<br>R39[15:0] | PLL_DEN   | R/W  | 42949672<br>95  | The fractional denominator.   |
| R40[15:0]<br>R41[15:0] | Solution   Solution |      | The initial state of the MASH engine first accumulator. Can be used to shift phase or optimize fractional spurs. Every time the MASH_SEED field is programmed, it ADDS this MASH seed to the existing one. To reset it, use the MASH_RESET_N bit. |   |
| R42[15:0]<br>R43[15:0] | PLL_NUM   | R/W  | 0   | The fractional numerator  |
| R44[13:8]              | OUTA_PWR  | R/W  | 31  | Adjusts output power. Higher numbers give more output power to a point, depending on the pullup component used.   |
| R44[7]                 | OUTB_PD   | R/W  | 1   | Powers down output B 0: Output B active 1: Output B powered down  |
| R44[6]                 | OUTA_PD   | R/W  | 0   | Powers down output A 0: Output A Active 1: Output A powered down  |
| R44[5]                 | MASH_RESET_N  | R/W  | 1   | Resets MASH circuitry to an initial state 0: Disabled. Fractional mode enabled. 1: Enabled. All fractions are ignored and MASH engine is reset.         |
| R44[2:0]               | MASH_ORDER R/W  |      | 0   | Sets the MASH order 0: Integer mode 1: First order modulator 2: Second order modulator 3: Third order modulator 4: Fourth order modulator 5-7: Reserved |



# **Table 26. Field Descriptions (continued)**

| Location   | Field    | Туре | Reset | Description   |
|------------|----------|------|-------|---|
| R45[12:11] | OUTA_MUX | R/W  | 1     | Selects what signal goes to RFoutA 0: Channel divider 1: VCO 2: Reserved 3: High impedance  |
| R45[10:9]  | OUT_ISEL | R/W  | 0     | Setting to a lower value allows slightly higher output power at higher frequencies at the expense of higher current consumption.  0: Maximum output power boost  3: No output power boost |
| R45[5:0]   | OUTB_PWR | R/W  | 31    | Output power setting for RFoutB.  |
| R46[1:0]   | OUTB_MUX | R/W  | 1     | Selects what signal goes to RFoutB 0: Channel divider 1: VCO 2: Sysref 3: High impedance  |

#### 7.6.6 Lock Detect Registers

### Figure 35. Registers Excluding Address

|     | D15 | D14 | D13 | D12 | D11 | D10 | D9 | D8  | D7  | D6 | D5 | D4 | D3 | D2 | D1 | D0          |
|-----|-----|-----|-----|-----|-----|-----|----|-----|-----|----|----|----|----|----|----|-------------|
| R59 | 0   | 0   | 0   | 0   | 0   | 0   | 0  | 0   | 0   | 0  | 0  | 0  | 0  | 0  | 0  | LD_T<br>YPE |
| R60 |     |     |     |     |     |     |    | LD_ | DLY |    |    |    |    |    |    |             |

LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

# **Table 27. Field Descriptions**

| Location  | Field   | Туре | Reset | Description   |
|-----------|---------|------|-------|---|
| R59[0]    | LD_TYPE | R/W  | 1     | Lock detect type 0: VCO calibration status 1: VCO calibration status and Vtune                                      |
| R60[15:0] | LD_DLY  | R/W  | 1000  | This is the delay added to the lock detect after the VCO calibration is successful. It is in phase-detector cycles. |

#### 7.6.7 MASH\_RESET

#### Figure 36. Registers Excluding Address

|     | D15                   | D14 | D13 | D12 | D11 | D10 | D9 | D8 | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 |
|-----|-----------------------|-----|-----|-----|-----|-----|----|----|----|----|----|----|----|----|----|----|
| R69 | MASH_RST_COUNT[31:16] |     |     |     |     |     |    |    |    |    |    |    |    |    |    |    |
| R70 |                       |     |     |     |     |     |    |    |    |    |    |    |    |    |    |    |

LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

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#### **Table 28. Field Descriptions**

| Location               | Field          | Туре | Reset | Description   |
|------------------------|----------------|------|-------|---|
| R69[15:0]<br>R70[15:0] | MASH_RST_COUNT | R/W  | 50000 | If not using this device in fractional mode with VCO_PHASE_SYNC=1, then this field can be set to 0. In phase-sync mode with fractions, this bit is used so that there is a delay for the VCO divider after the MASH is reset. This delay must be set to greater than the lock time of the PLL. It does impact the latency time of the SYNC feature. |

SNAS696 – MARCH 2017 www.ti.com

# TEXAS INSTRUMENTS

# 7.6.8 SysREF Registers

# Figure 37. Registers Excluding Address

|     | D15 | D14    | D13    | D12 | D11 | D10 | D9     | D8     | D7         | D6      | D5   | D4                   | D3                | D2                        | D1  | D0 |  |  |  |
|-----|-----|--------|--------|-----|-----|-----|--------|--------|------------|---------|------|----------------------|-------------------|---------------------------|-----|----|--|--|--|
| R71 | 0   | 0      | 0      | 0   | 0   | 0   | 0      | 0      | SYSR       | REF_DIV | _PRE | SYSR<br>EF_P<br>ULSE | SYSR<br>EF_E<br>N | SYSR<br>EF_R<br>EPEA<br>T | 0   | 1  |  |  |  |
| R72 | 0   | 0      | 0      | 0   | 0   |     |        |        | SYSREF_DIV |         |      |                      |                   |                           |     |    |  |  |  |
| R73 | 0   | 0      | 0      | 0   |     | JI  | ESD_DA | C2_CTR | RL         |         |      | JI                   | ESD_DA            | C1_CTR                    | RL. |    |  |  |  |
| R74 | SY  | SREF_P | ULSE_C | CNT |     | JI  | ESD_DA | C4_CTR | RL         |         |      | JI                   | ESD_DA            | JESD DAC3 CTRL            |     |    |  |  |  |

LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

# **Table 29. Field Descriptions**

| Location   | Field            | Туре | Reset | Description  |
|------------|------------------|------|-------|--|
| R71[7:5]   | STSREF_DIV_PRE   | R/W  | 4     | Pre divider for SYSREF 2: Divide by 2 4: Divide by 4 All other states: invalid |
| R71[4]     | SYSREF_PULSE     | R/W  | 0     | Enable pulser mode in master mode 0: Disabled 1: Enabled                       |
| R71[3]     | SYSREF_EN        | R/W  | 0     | Enable SYSREF  |
| R71[2]     | SYSREF_REPEAT    | R/W  | 0     | Enable repeater mode 0: Master mode 1: Repeater mode                           |
| R72[10:0]  | SYSREF_DIV       | R/W  | 0     | Divider for the SYSREF<br>Fout = Fin / (2 x SYSREF_DIV + 4)                    |
| R73[5:0]   | JESD_DAC1_CTRL   | R/W  | 63    | These are the adjustments for the delay for the SYSREF. Two of                 |
| R73[11:6]  | JESD_DAC2_CTRL   | R/W  | 0     | these must be zero and the other two values must sum to 63.                    |
| R74[5:0]   | JESD_DAC3_CTRL   | R/W  | 0     |  |
| R74[11:6]  | JESD_DAC4_CTRL   | R/W  | 0     |  |
| R74[15:12] | SYSREF_PULSE_CNT | R/W  | 0     | Number of pulses in pulse mode in master mode                                  |



# 7.6.9 CHANNEL Divider Registers

# Figure 38. Registers Excluding Address

| Reg | 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8     | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|-----|----|----|----|----|----|----|---|-------|---|---|---|---|---|---|---|---|
| R75 | 0  | 0  | 0  | 0  | 1  |    |   | CHDIV |   |   | 0 | 0 | 0 | 0 | 0 | 0 |

LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

# **Table 30. Field Descriptions**

| Location  | Field | Туре | Reset | Description       |
|-----------|-------|------|-------|-------------------|
| R75[10:6] | CHDIV | R/W  | 0     | VCO divider value |
|           |       |      |       | 0: 2              |
|           |       |      |       | 1: 4              |
|           |       |      |       | 2: 6              |
|           |       |      |       | 3: 8              |
|           |       |      |       | 4: 12             |
|           |       |      |       | 5: 16             |
|           |       |      |       | 6: 24             |
|           |       |      |       | 7: 32             |
|           |       |      |       | 8: 48             |
|           |       |      |       | 9: 64             |
|           |       |      |       | 10: 72            |
|           |       |      |       | 11: 96            |
|           |       |      |       | 12: 128           |
|           |       |      |       | 13: 192           |
|           |       |      |       | 14: 256           |
|           |       |      |       | 15: 384           |
|           |       |      |       | 16: 512           |
|           |       |      |       | 17: 768           |
|           |       |      |       | 18-31: Reserved   |

# 7.6.10 Ramping and Calibration Fields

# Figure 39. Registers Excluding Address

|     | D15               | D14                | D13 | D12 | D11                         | D10 | D9                         | D8               | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 |
|-----|-------------------|--------------------|-----|-----|-----------------------------|-----|----------------------------|------------------|----|----|----|----|----|----|----|----|
| R78 | 0                 | 0                  | 0   | 0   | RAMP<br>_THR<br>ESH[3<br>2] | 0   | QUIC<br>K_RE<br>CAL_<br>EN | VCO_CAPCTRL_STRT |    |    |    |    |    | 1  |    |    |
| R79 |                   | RAMP_THRESH[31:16] |     |     |                             |     |                            |                  |    |    |    |    |    |    |    |    |
| R80 | RAMP_THRESH[15:0] |                    |     |     |                             |     |                            |                  |    |    |    |    |    |    |    |    |

LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

# **Table 31. Field Descriptions**

| Location                          | Field            | Туре | Reset | Description   |
|-----------------------------------|------------------|------|-------|---|
| R78[11]<br>R79[15:0]<br>R80[15:0] | RAMP_THRESH      | R/W  | 0     | This sets how much the ramp can change the VCO frequency before calibrating. If this frequency is chosen to be $\Delta f$ , then it is calculated as follows: RAMP_THRESH = $(\Delta f / f_{PD}) \times 16777216$ |
| R78[9]                            | QUICK_RECAL_EN   | R/W  | 0     | Causes the initial VCO_CORE, VCO_CAPCTRL, and VCO_DACISET to be based on the last value. Useful if the frequency change is small, as is often the case for ramping.  0: Disabled  1: Enabled                      |
| R78[8:1]                          | VCO_CAPCTRL_STRT | R/W  | 0     | This is the capcode that is used for the calibration when VCO_CAPCTRL_STRT_EN = 1. Smaller values yield a higher frequency band within a VCO core. Valid number range is 0 to 183.                                |

SNAS696 – MARCH 2017 www.ti.com

# TEXAS INSTRUMENTS

#### 7.6.11 Ramping Registers

These registers are only relevant for ramping functions and are enabled if and only if RAMP\_EN (R0[15]) = 1.

#### 7.6.11.1 Ramp Limits

Figure 40. Registers Excluding Address

|     | D15 | D14   | D13 | D12 | D11 | D10 | D9  | D8      | D7      | D6     | D5 | D4 | D3 | D2 | D1 | D0                              |
|-----|-----|---|-----|-----|-----|-----|-----|---------|---------|--------|----|----|----|----|----|---------------------------------|
| R81 | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0       | 0       | 0      | 0  | 0  | 0  | 0  | 0  | RAMP<br>_LIMI<br>T_HIG<br>H[32] |
| R82 |     |   |     |     |     |     | RAM | P_LIMIT | _HIGH[3 | 31:16] |    | •  |    |    |    |                                 |
| R83 |     | RAMP_LIMIT_HIGH[15:0]                                     |     |     |     |     |     |         |         |        |    |    |    |    |    |                                 |
| R84 | 0   | 0 0 0 0 0 0 0 0 0 0 0 0 0 0 RAMP<br>LIMI<br>T_LO<br>W[32] |     |     |     |     |     |         |         |        |    |    |    |    |    |                                 |
| R85 |     | RAMP_LIMIT_LOW[31:16]                                     |     |     |     |     |     |         |         |        |    |    |    |    |    |                                 |
| R86 |     | RAMP_LIMIT_LOW[15:0]                                      |     |     |     |     |     |         |         |        |    |    |    |    |    |                                 |

LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

#### **Table 32. Field Descriptions**

| Location                         | Field           | Туре | Reset | Description  |
|----------------------------------|-----------------|------|-------|--|
| R81[0]<br>R82[15:0]<br>R83[15:0] | RAMP_LIMIT_HIGH | R/W  | 0     | This sets a maximum frequency that the ramp can not exceed so that the VCO does not get set beyond a valid frequency range. Suppose $f_{HIGH}$ is this frequency and $f_{VCO}$ is the starting VCO frequency then: For $f_{MAX} \ge f_{VCO}$ : RAMP_LIMIT_HIGH = $(f_{HIGH} - f_{VCO})/f_{PD} \times 16777216$ For $f_{MAX} < f_{VCO}$ this is not a valid condition to choose.              |
| R84[0]<br>R85[15:0]<br>R86[15:0] | RAMP_LIMIT_LOW  | R/W  | 0     | This sets a minimum frequency that the ramp can not exceed so that the VCO does not get set beyond a valid frequency range. Suppose $f_{LOW}$ is this frequency and $f_{VCO}$ is the starting VCO frequency then: For $f_{LOW} \le f_{VCO}$ : RAMP_LIMIT_LOW = $2^{32}$ - ( $f_{LOW}$ - $f_{VCO}$ ) / $f_{PD}$ × 16777216 For $f_{LOW}$ > $f_{VCO}$ this is not a valid condition to choose. |

7.6.11.2

# 7.6.11.3 Ramping Triggers, Burst Mode, and RAMP0\_RST

# Figure 41. Registers Excluding Address

|     | D15                       | D14                | D13 | D12 | D11 | D10 | D9                      | D8 | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0           |
|-----|---------------------------|--------------------|-----|-----|-----|-----|-------------------------|----|----|----|----|----|----|----|----|--------------|
| R96 | RAMP<br>_BUR<br>ST_E<br>N | R PAMP BURST COUNT |     |     |     |     |                         |    |    |    | 0  | 0  |    |    |    |              |
| R97 | RAMP<br>0_RS<br>T         | 0                  | 0   | 0   | 1   |     | RAMP_TRIGB RAMP_TRIGA 0 |    |    |    |    |    |    |    |    | _BURS<br>RIG |

LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

# **Table 33. Field Descriptions**

| Location         | Field            | Туре | Reset | Description  |
|------------------|------------------|------|-------|--|
| R96[15]          | RAMP_BURST_EN    | R/W  | 0     | Enables burst ramping mode. In this mode, a RAMP_BURST_COUNT ramps are sent out when RAMP_EN is set from 0 to 1.  0: Disabled 1: Enabled   |
| RAMP96[1<br>4:2] | RAMP_BURST_COUNT | R/W  | 0     | Sets how many ramps are run in burst ramping mode.   |
| R97[15]          | RAMP0_RST        | R/W  | 0     | Resets RAMP0 at start of ramp to eliminate round-off errors.  Must only be used in automatic ramping mode.  0: Disabled  1: Enabled  |
| R97[6:3]         | RAMP_TRIGA       | R/W  | 0     | Multipurpose Trigger A definition: 0: Disabled 1: RampCLK pin rising edge 2: RampDIR pin rising edge 4: Always triggered 9: RampCLK pin falling edge 10: RampDIR pin falling edge All other states: reserved                           |
| R97[10:7]        | RAMP_TRIGB       | R/W  | 0     | Multipurpose trigger B definition: 0: Disabled 1: RampCLK pin Rising Edge 2: RampDIR pin Rising Edge 4: Always Triggered 9: RampCLK pin Falling Edge 10: RampDIR pin Falling Edge All other states: Reserved                           |
| R97[1:0]         | RAMP_BURST_TRIG  | R/W  | 0     | Ramp burst trigger definition that triggers the next ramp in the count. Note that RAMP_EN starts the count, not this word.  0: Disabled  1: RampCLK pin rising edge  5: CMP0 detected  8: Always triggered  All other states: reserved |

# 7.6.11.4 Ramping Configuration





# Figure 42. Registers Excluding Address

|      | D15 | D14                                    | D13 | D12 | D11 | D10 | D9     | D8      | D7       | D6      | D5 | D4 | D3             | D2    | D1             | D0                |
|------|-----|--|-----|-----|-----|-----|--------|---------|----------|---------|----|----|----------------|-------|----------------|-------------------|
| R98  |     |  |     |     |     | R   | AMP0_I | NC[29:1 | 6]       |         |    |    |                |       | 0              | RAMP<br>0_DL<br>Y |
| R99  |     |  |     |     |     |     | F      | RAMP0_  | INC[15:0 | 0]      |    |    |                |       |                |                   |
| R100 |     | RAMP0_LEN                              |     |     |     |     |        |         |          |         |    |    |                |       |                |                   |
| R101 | 0   | RAMP RAMP RAMP RAMP                    |     |     |     |     |        |         |          |         |    |    | /IP0_<br>_TRIG |       |                |                   |
| R102 | 0   | 0                                      |     |     |     |     |        | R       | AMP1_I   | NC[29:1 | 6] |    |                |       |                |                   |
| R103 |     |  |     |     |     |     | F      | RAMP1_  | INC[15:0 | 0]      |    |    |                |       |                |                   |
| R104 |     |  |     |     |     |     |        | RAMP    | 1_LEN    |         |    |    |                |       |                |                   |
| R105 |     | RAMP_DLY_CNT  RAMP 1 0 0 0 UAL T       |     |     |     |     |        |         |          |         |    |    | 0              |       | /IP1_<br>_TRIG |                   |
| R106 | 0   | 0 0 0 0 0 0 0 0 0 RAMP_TRIG 0 RAMP_CAL |     |     |     |     |        |         |          |         |    |    | SCALE.         | _COUN |                |                   |

LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

# **Table 34. Field Descriptions**

| Location                 | Field           | Туре | Reset | Description   |
|--------------------------|-----------------|------|-------|---|
| R98[15:2]<br>R99[15:0]   | RAMP0_INC       | R/W  | 0     | 2's complement of the amount the RAMP0 is incremented in phase detector cycles.   |
| R98[0]                   | RAMP0_DLY       | R/W  | 0     | Enabling this bit uses two clocks instead of one to clock the ramp. Effectively doubling the length. 0: Normal ramp length 1: Double ramp length                                      |
| R100[15:0]               | RAMP0_LEN       | R/W  | 0     | Length of RAMP0 in phase detector cycles  |
| R101[6]                  | RAMP1_DLY       | R/W  | 0     | Enabling this bit uses two clocks instead of one to clock the ramp. Effectively doubling the length.  0: Normal ramp length  1: Double ramp length                                    |
| R101[5]                  | RAMP1_RST       | R/W  | 0     | Resets RAMP1 to eliminate rounding errors. Must be used in automatic ramping mode. 0: Disabled 1: Enabled   |
| R101[4]                  | RAMP0_NEXT      | R/W  | 0     | Defines what ramp comes after RAMP0 0: RAMP0 1: RAMP1   |
| R101[1:0]                | RAMP0_NEXT_TRIG | R/W  | 0     | Defines what triggers the next ramp 0: RAMPO_LEN timeout counter 1: Trigger A 2: Trigger B 3: Reserved  |
| R102[13:0]<br>R103[15:0] | RAMP1_INC       | R/W  | 0     | 2's complement of the amount the RAMP0 is incremented in phase detector cycles.   |
| R104[15:0]               | RAMP1_LEN       | R/W  | 0     | Length of RAMP1 in phase detector cycles  |
| R105[15:6]               | RAMP_DLY_CNT    | R/W  | 0     | This is the amount of time for the VCO calibration in automatic mode. If the VCO calibration is less, then it is this time. If it is more then the time is the VCO caliabration time. |
| R105[5]                  | RAMP_MANUAL     | R/W  | 0     | Enables manual ramping mode, otherwise automatic mode 0: Automatic ramping mode 1: Manual ramping mode  |
| R105[4]                  | RAMP1_NEXT      | R/W  | 0     | Determines what ramp comes after RAMP1: 0: RAMP0 1: RAMP1   |



# Table 34. Field Descriptions (continued)

| Location  | Field            | Туре | Reset | Description  |
|-----------|------------------|------|-------|--|
| R105[1:0] | RAMP_NEXT_TRIG   | R/W  | 0     | Defines what triggers the next ramp 0: RAMP1_LEN timeout counter 1: Trigger A 2: Trigger B 3: Reserved |
| R106[4]   | RAMP_TRIG_CAL    | R/W  | 0     | Enabling this bit forces the VCO to calibrate after the ramp.  |
| R106[2:0] | RAMP_SCALE_COUNT | R/W  | 7     | Multiplies RAMP_DLY count by 2 <sup>RAMP_SCALE_COUNT</sup>   |

# 7.6.12 Readback Registers

# Figure 43. Registers Excluding Address

|      | D15 | D14 | D13 | D12 | D11 | D10        | D9         | D8             | D7               | D6 | D5 | D4 | D3 | D2 | D1 | D0 |
|------|-----|-----|-----|-----|-----|------------|------------|----------------|------------------|----|----|----|----|----|----|----|
| R110 | 0   | 0   | 0   | 0   | 0   | rb_<br>VTU | LD_<br>JNE | 0              | rb_VCO_SEL       |    | 0  | 0  | 0  | 0  | 0  |    |
| R111 | 0   | 0   | 0   | 0   | 0   | 0          | 0          | 0              | 0 rb_VCO_CAPCTRL |    |    |    |    |    |    |    |
| R112 | 0   | 0   | 0   | 0   | 0   | 0          | 0          | rb_VCO_DACISET |                  |    |    |    |    |    |    |    |

LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

# **Table 35. Field Descriptions**

| Location   | Field          | Туре | Reset | Description   |
|------------|----------------|------|-------|---|
| R110[10:9] | rb_LD_VTUNE    | R    | 0     | Readback of Vtune lock detect 0: Unlocked (Vtune low) 1: Unlocked (Vtune high) 2: Locked 3: Invalid State |
| R110[7:5]  | rb_VCO_SEL     | R    | 0     | Reads back the actual VCO that the calibration has selected. 0: Invalid 1: VCO1 7: VCO7                   |
| R111[7:0]  | rb_VCO_CAPCTRL | R    | 183   | Reads back the actual CAPCTRL capcode value the VCO calibration has chosen.                               |
| R112[8:0]  | rb_VCO_DACISET | R    | 170   | Reads back the actual amplitude (DACISET) value that the VCO calibration has chosen.                      |

SNAS696 – MARCH 2017 www.ti.com



### 8 Application and Implementation

#### NOTE

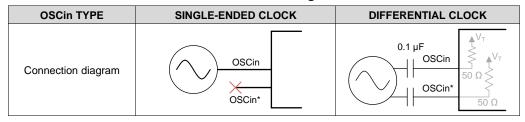
Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes. Customers should validate and test their design implementation to confirm system functionality.

### 8.1 Application Information

#### 8.1.1 OSCin Configuration

OSCin supports single or differential-ended clock.

**Table 36. OSCin Configuration** 



Input clock definitions are shown in Figure 44:

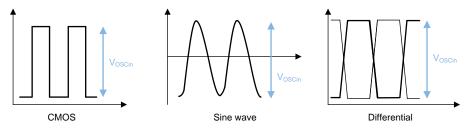


Figure 44. Input Clock Definitions

#### 8.1.2 OSCin Slew Rate

The slew rate of the OSCin signal can have an impact on the spurs and phase noise of the LMX2594 if it is too low. In general, the best performance is for a high slew rate, but lower amplitude signal, such as LVDS.

#### 8.1.3 RF Output Buffer Power Control

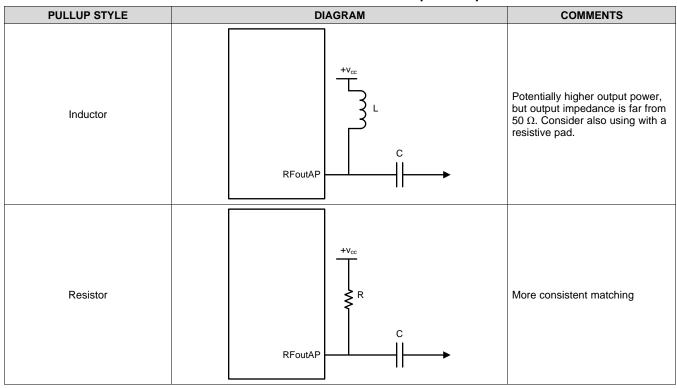
The OUTA\_PWR and OUTB\_PWR registers can be used to control the output power of the output buffers. The setting for optimal power may depend on the pullup component, but typically is around 50. The higher the setting, the higher the current consumption of the output buffer.

#### 8.1.4 RF Output Buffer Pullup

The choice of output buffer components is very important and can have a profound impact on the output power. Table 37 shows how to treat each pin. If using single-ended, the pullup is still needed, and user puts a  $50-\Omega$  resistor after the capacitor.



#### Table 37. Different Methods for Pullup on Outputs



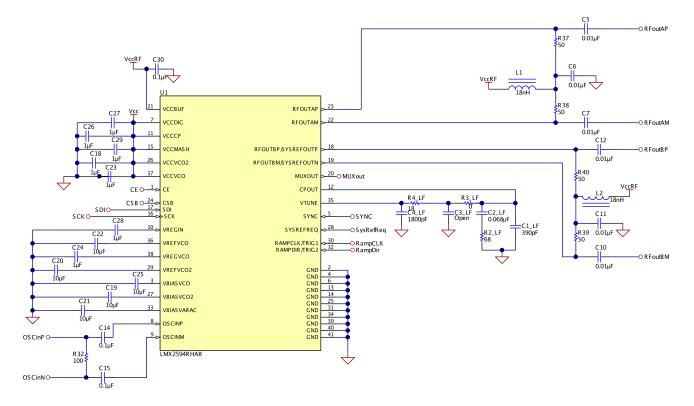
**Table 38. Output Pullup Configuration** 

| COMPONENT | COMPONENT VALUE       |  |  |  |
|-----------|-----------------------|--|--|--|
| Inductor  | Varies with frequency |  |  |  |
| Resistor  | 50 Ω                  | Vishay FC0402E50R0BST1                 |  |  |
| Capacitor | Varies with frequency | ATC 520L103KT16T<br>ATC 504L50R0FTNCFT |  |  |

SNAS696 – MARCH 2017 www.ti.com

# TEXAS INSTRUMENTS

#### 8.2 Typical Application



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Figure 45. Typical Application Schematic

#### 8.2.1 Design Requirements

The design of the loop filter is complex and is typically done with software. The PLLatinum Sim software is an excellent resource for doing this and the design is shown in the Figure 46. For those interested in the equations involved, the *PLL Performance, Simulation, and Design Handbook* listed in the end of this document goes into great detail as to theory and design of PLL loop filters.



### **Typical Application (continued)**

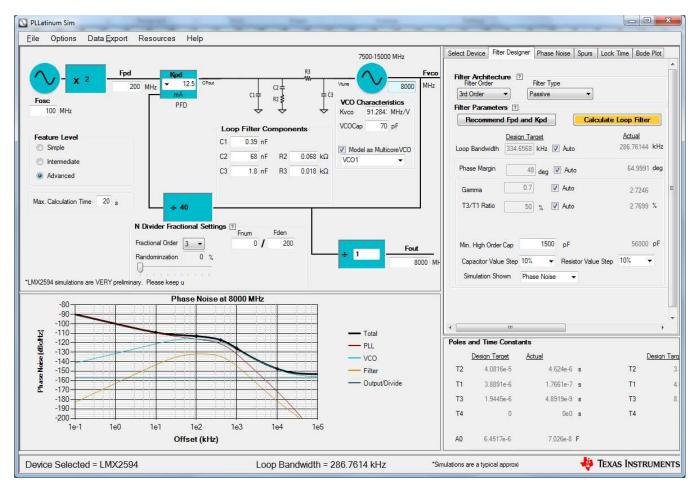


Figure 46. PLLatinum Sim Design Screen

#### 8.2.2 Detailed Design Procedure

The integration of phase noise over a certain bandwidth (jitter) is an performance specification that translates to signal-to-noise ratio. Phase noise inside the loop bandwidth is dominated by the PLL, while the phase noise outside the loop bandwidth is dominated by the VCO. Generally, jitter is lowest if loop bandwidth is designed to the point where the two intersect. A higher phase margin loop filter design has less peaking at the loop bandwidth and thus lower jitter. The tradeoff with this is longer lock times and spurs must be considered in design as well.

SNAS696 – MARCH 2017 www.ti.com

# TEXAS INSTRUMENTS

### **Typical Application (continued)**

#### 8.2.3 Application Curves

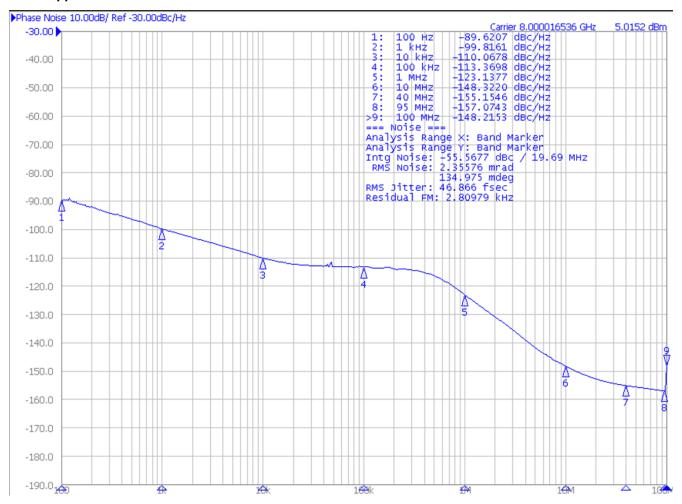


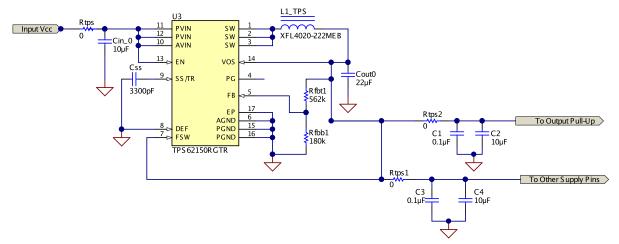
Figure 47. Typical Jitter



### 9 Power Supply Recommendations

TI recommends placement of 100 nF close to each of the power supply pins. If fractional spurs are a large concern, using a ferrite bead to each of these power supply pins can reduce spurs to a small degree. This device has integrated LDOs, which improves the resistance to power supply noise. However, the pullup components on the RFoutA and RFoutB pins on the outputs have a direct connection to the power supply, so extra care must be made to ensure that the voltage is clean for these pins. Figure 48 is a typical application example.

This device can be powered by an external DC-DC buck converter, such as the TPS62150. Note that although Rtps, Rtps1, and Rtps2 are 0  $\Omega$  in the schematic, they could be potentially replaced with a larger resistor value or inductor value for better power supply filtering.



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Figure 48. Using the TPS62150 as a Power Supply

# TEXAS INSTRUMENTS

### 10 Layout

#### 10.1 Layout Guidelines

In general, the layout guidelines are similar to most other PLL devices. Here are some specific guidelines.

- GND pins may be routed on the package back to the DAP.
- The OSCin pins, these are internally biased and must be AC coupled.
- If not used, RampCLK, RampDIR, and SysRefReq can be grounded to the DAP.
- For the Vtune pin, try to get a loop filter capacitor as close to this as possible. This may mean separating it from the rest of the loop filter.
- For the outputs, keep the pullup component as close as possible to the pin and use the same component on each side of the differential pair.
- If a single-ended output is needed, the other side must have the same loading and pullup. However, the routing for the used side can be optimized by routing the complementary side through a via to the other side of the board. On this side, use the same pullup and make the load look equivalent to the side that is used.
- Ensure DAP on device is well-grounded with many vias, preferably copper filled.
- Have a thermal pad that is as large as the LMX2594 exposed pad. Add vias to the thermal pad to maximize thermal performance.
- Use a low loss dielectric material, such as Rogers 4003, for optimal output power.
- See instructions for the LMX2594EVM (LMX2594 EVM Instructions, 15 GHz Wideband Low Noise PLL with Integrated VCO) for more details on layout.



# 10.2 Layout Example

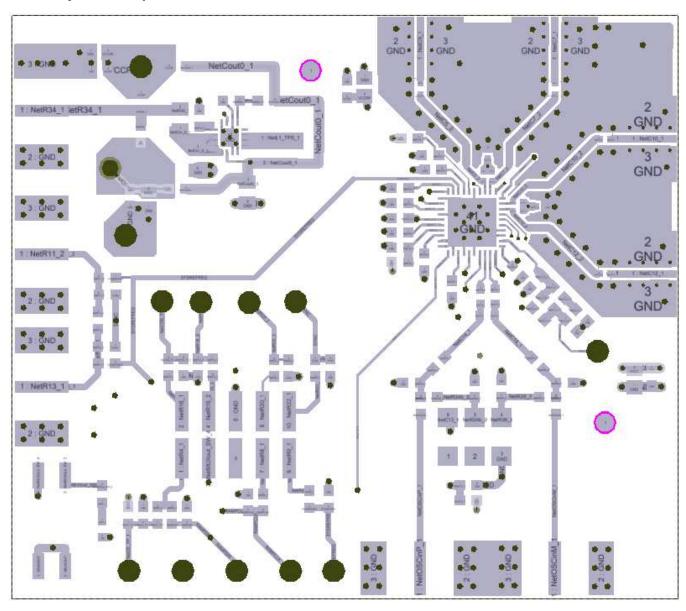


Figure 49. LMX2594 PCB Layout

# TEXAS INSTRUMENTS

#### 11 Device and Documentation Support

#### 11.1 Device Support

#### 11.1.1 Third-Party Products Disclaimer

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#### 11.1.2 Development Support

Texas Instruments has several software tools to aid in the development at www.ti.com. Among these tools are:

- EVM software to understand how to program the LMX2594 and for programming the EVM board.
- EVM board instructions for seeing typical measured data with detailed measurement conditions and a complete design.
- PLLatinum Sim program for designing loop filters, simulating phase noise, and simulating spurs on the LMX2594.

#### 11.2 Documentation Support

#### 11.2.1 Related Documentation

For related documentation see the following:

- AN-1879 Fractional N Frequency Synthesis
- PLL Performance, Simulation, and Design Handbook
- LMX2594 EVM Instructions, 15 GHz Wideband Low Noise PLL with Integrated VCO

#### 11.3 Receiving Notification of Documentation Updates

To receive notification of documentation updates, navigate to the device product folder on ti.com. In the upper right corner, click on *Alert me* to register and receive a weekly digest of any product information that has changed. For change details, review the revision history included in any revised document.

#### 11.4 Community Resources

The following links connect to TI community resources. Linked contents are provided "AS IS" by the respective contributors. They do not constitute TI specifications and do not necessarily reflect TI's views; see TI's Terms of Use.

TI E2E™ Online Community TI's Engineer-to-Engineer (E2E) Community. Created to foster collaboration among engineers. At e2e.ti.com, you can ask questions, share knowledge, explore ideas and help solve problems with fellow engineers.

**Design Support** *TI's Design Support* Quickly find helpful E2E forums along with design support tools and contact information for technical support.

#### 11.5 Trademarks

E2E is a trademark of Texas Instruments.

#### 11.6 Electrostatic Discharge Caution



These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

# 11.7 Glossary

SLYZ022 — TI Glossary.

This glossary lists and explains terms, acronyms, and definitions.



SNAS696 - MARCH 2017



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# 12 Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.



## PACKAGE OPTION ADDENDUM

30-Mar-2017

#### **PACKAGING INFORMATION**

| Orderable Device | Status | Package Type | _       | Pins | _    | Eco Plan                   | Lead/Ball Finish | MSL Peak Temp       | Op Temp (°C) | Device Marking | Samples |
|------------------|--------|--------------|---------|------|------|----------------------------|------------------|---------------------|--------------|----------------|---------|
|                  | (1)    |              | Drawing |      | Qty  | (2)                        | (6)              | (3)                 |              | (4/5)          |         |
| LMX2594RHAR      | ACTIVE | VQFN         | RHA     | 40   | 2500 | Green (RoHS<br>& no Sb/Br) | CU NIPDAUAG      | Level-3-260C-168 HR | -40 to 85    | LMX2594        | Samples |
| LMX2594RHAT      | ACTIVE | VQFN         | RHA     | 40   | 250  | Green (RoHS<br>& no Sb/Br) | CU NIPDAUAG      | Level-3-260C-168 HR | -40 to 85    | LMX2594        | Samples |

(1) The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

**TBD:** The Pb-Free/Green conversion plan has not been defined.

**Pb-Free (RoHS):** TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

**Pb-Free (RoHS Exempt):** This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

- (3) MSL, Peak Temp. The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.
- (4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.
- (5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.
- (6) Lead/Ball Finish Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width.

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# **PACKAGE OPTION ADDENDUM**

30-Mar-2017

| In no event shall TI's liabili | ity arising out of such information | exceed the total purchase | price of the TI part(s) at issue | in this document sold by | TI to Customer on an annual basis. |
|--------------------------------|-------------------------------------|---------------------------|----------------------------------|--------------------------|------------------------------------|
|                                |                                     |                           |                                  |                          |                                    |

# PACKAGE MATERIALS INFORMATION

www.ti.com 31-Mar-2017

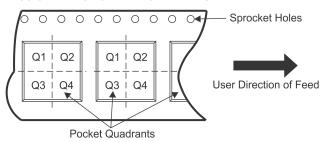
# TAPE AND REEL INFORMATION





|    | Dimension designed to accommodate the component width     |
|----|---|
|    | Dimension designed to accommodate the component length    |
| K0 | Dimension designed to accommodate the component thickness |
| W  | Overall width of the carrier tape                         |
| P1 | Pitch between successive cavity centers                   |

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



#### \*All dimensions are nominal

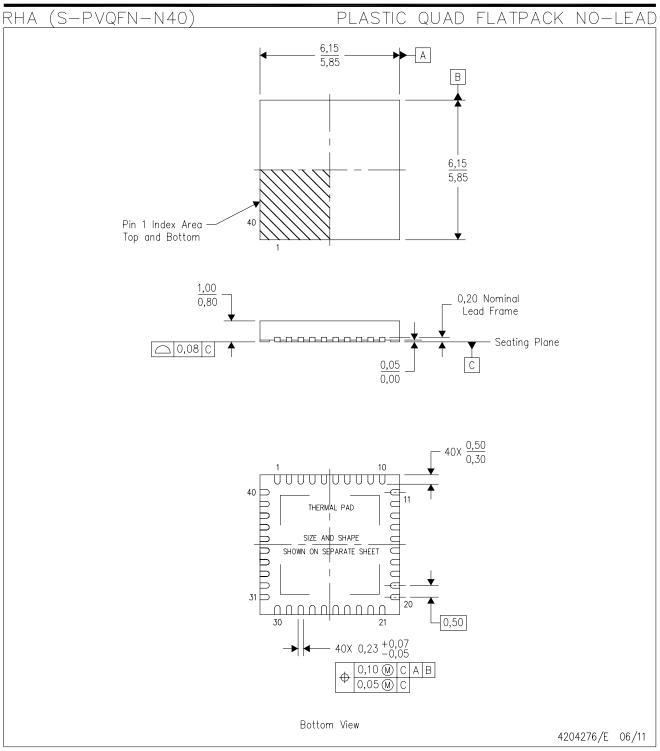
| Device Device | Package<br>Type | Package<br>Drawing |    | SPQ  | Reel<br>Diameter | Reel<br>Width | A0<br>(mm) | B0<br>(mm) | K0<br>(mm) | P1<br>(mm) | W<br>(mm) | Pin1<br>Quadrant |
|---------------|-----------------|--------------------|----|------|------------------|---------------|------------|------------|------------|------------|-----------|------------------|
|               | - 7             | -                  |    |      |                  | W1 (mm)       | (,         | (,         | ()         | (,         | (         |                  |
| LMX2594RHAR   | VQFN            | RHA                | 40 | 2500 | 330.0            | 16.4          | 6.3        | 6.3        | 1.5        | 12.0       | 16.0      | Q1               |
| LMX2594RHAT   | VQFN            | RHA                | 40 | 250  | 178.0            | 16.4          | 6.3        | 6.3        | 1.5        | 12.0       | 16.0      | Q1               |

www.ti.com 31-Mar-2017



#### \*All dimensions are nominal

| Device      | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |  |
|-------------|--------------|-----------------|------|------|-------------|------------|-------------|--|
| LMX2594RHAR | VQFN         | RHA             | 40   | 2500 | 367.0       | 367.0      | 38.0        |  |
| LMX2594RHAT | VQFN         | RHA             | 40   | 250  | 210.0       | 185.0      | 35.0        |  |



- NOTES: A. All linear dimensions are in millimeters. Dimensioning and tolerancing per ASME Y14.5M—1994.
  - B. This drawing is subject to change without notice.
  - C. QFN (Quad Flatpack No-Lead) Package configuration.
  - D. The package thermal pad must be soldered to the board for thermal and mechanical performance.
  - E. See the additional figure in the Product Data Sheet for details regarding the exposed thermal pad features and dimensions.
  - F. Package complies to JEDEC MO-220 variation VJJD-2.



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